

## Energy Measurement Processor for Single-Phase Power-Supply Units

### DESCRIPTION

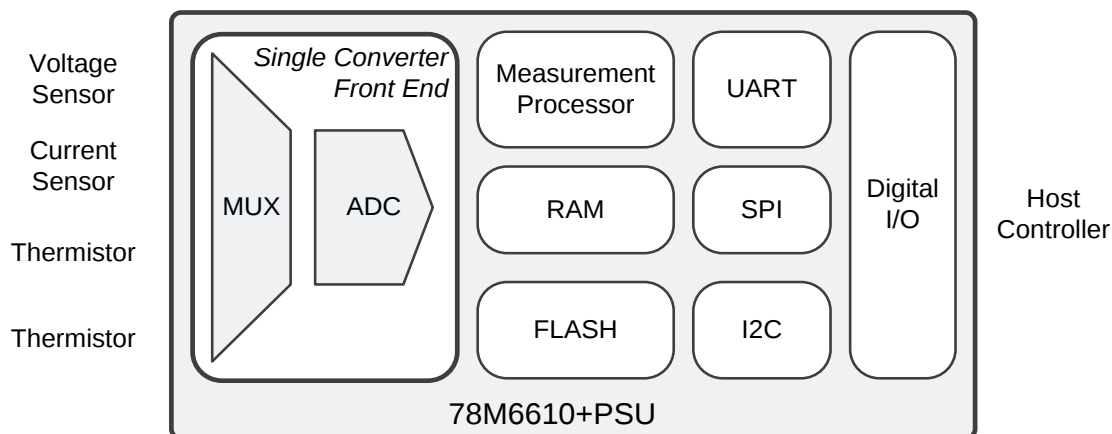
The 78M6610+PSU is a single-core energy measurement processor for single-phase power supplies. It is designed specifically for real-time monitoring at the input of AC/DC power converters used in data centers and IT server rooms. It is available in either a 24-pin QFN or 16-pin TSSOP package for optimal space savings.

The 78M6610+PSU provides four analog inputs (two differential and two single ended) for interfacing to voltage, current, and two optional temperature sensors. Scaled voltages from the sensors are fed to the single converter front-end utilizing a high-resolution delta-sigma converter. An embedded 24-bit energy measurement processor (EMP) and firmware performs all the necessary computation, compensation, and data formatting for accurate, real-time reporting to the host. With integrated flash memory, the 78M6610+PSU is a completely autonomous solution capable of storing nonvolatile data such as calibration coefficients and input configuration settings.

The 78M6610+PSU is designed to interface to the host processor via the UART interface. Alternatively, SPI or I<sup>2</sup>C may also be used. Supported current sensors include Current Transformers (CT) and Resistive Shunts.

### FEATURES

- Delta-sigma ADC with precision voltage reference
- Internal or external oscillator timing reference
- SPI, I<sup>2</sup>C, or UART interface options with configurable I/O pins for alarm signaling, address pins, or user control
- 24-bit energy measurement processor (EMP) with integrated firmware and flash memory provides the user with:
  - o True RMS calculations for current, voltage, line frequency, real power, reactive power, apparent power, and power factor
  - o Compensation for ambient temperature, sensor tolerances, offsets, and EMI filter components
  - o Real-time data accumulation based on an integer number of AC cycles
  - o Quick calibration routines for manufacturability
  - o Up to two voltage inputs for optional connection to thermal sensors



## Table of Contents

|          |                                                                    |           |
|----------|--------------------------------------------------------------------|-----------|
| <b>1</b> | <b>On-Chip Resources Overview .....</b>                            | <b>5</b>  |
| 1.1      | Clock Management .....                                             | 6         |
| 1.2      | Power-On Reset, WD Timer, and Reset Circuitry .....                | 7         |
| 1.3      | Analog Front-End and Conversion .....                              | 8         |
| 1.4      | 24-Bit Energy Measurement Processor (EMP).....                     | 8         |
| 1.5      | Flash and RAM .....                                                | 8         |
| 1.6      | Communication Peripherals.....                                     | 8         |
| 1.7      | Multi-Purpose Digital I/O Pins.....                                | 9         |
| 1.8      | Alarm Pins (ACFAULT, ACCRIT) .....                                 | 9         |
| <b>2</b> | <b>Functional Description and Operation .....</b>                  | <b>10</b> |
| 2.1      | Voltage and Current Inputs Conditioning.....                       | 10        |
| 2.1.1    | High Pass Filters (HPF) and Offset Correction.....                 | 10        |
| 2.1.2    | Phase Compensation .....                                           | 10        |
| 2.2      | Current and Voltage RMS Calculations .....                         | 11        |
| 2.3      | Power Calculations and Power Factor.....                           | 12        |
| 2.3.1    | Active Power Calculation .....                                     | 12        |
| 2.3.2    | Apparent Power .....                                               | 12        |
| 2.3.3    | Power Factor.....                                                  | 12        |
| 2.3.4    | Reactive Power.....                                                | 12        |
| 2.4      | Fundamental and Harmonics Calculations .....                       | 13        |
| 2.5      | Accumulation Interval.....                                         | 13        |
| 2.6      | Zero-Crossing Detection .....                                      | 14        |
| 2.7      | Alarms .....                                                       | 14        |
| 2.8      | Voltage and Current Min/Max and Peak Tracking .....                | 15        |
| 2.8.1    | Voltage and Current Min/Max Tracking .....                         | 15        |
| 2.8.2    | Voltage and Current Peak Tracking .....                            | 15        |
| 2.9      | X+Y Capacitor Current and I/R Voltage Drop Compensation .....      | 15        |
| 2.9.1    | X+Y Capacitor Compensation .....                                   | 15        |
| 2.9.2    | I/R Voltage Drop Compensation .....                                | 16        |
| 2.10     | External Temperature Monitor .....                                 | 16        |
| 2.11     | Voltage Sag and Surge Detection .....                              | 17        |
| 2.12     | Relay Control .....                                                | 18        |
| 2.12.1   | Autonomous Mode.....                                               | 18        |
| 2.12.2   | Slave Mode .....                                                   | 18        |
| 2.12.3   | Activation Delay .....                                             | 18        |
| 2.13     | On-Chip Calibration Routines .....                                 | 20        |
| 2.13.1   | Voltage and Current Gain Calibration .....                         | 20        |
| 2.13.2   | Offset Calibration .....                                           | 20        |
| 2.13.3   | X+Y Capacitor and R Compensation Coefficient Calibration .....     | 20        |
| 2.13.4   | On-Chip Temperature Calibration.....                               | 21        |
| 2.13.5   | External Temperature Calibration.....                              | 21        |
| <b>3</b> | <b>Data Access and Configurability.....</b>                        | <b>22</b> |
| 3.1      | Register Descriptions .....                                        | 22        |
| 3.2      | Scaling Registers (Iscale, Vscale, Pscale, Tscale, Fscale) .....   | 24        |
| 3.3      | Output Registers .....                                             | 25        |
| 3.4      | Input Registers (Setup and Calibration).....                       | 27        |
| 3.5      | Relay Configuration .....                                          | 29        |
| 3.6      | DIOState Register.....                                             | 30        |
| 3.7      | Alarms and Alarms Configuration Registers.....                     | 31        |
| 3.7.1    | Alarms Status Register (address 0x30) .....                        | 31        |
| 3.7.2    | AlarmSticky Register (address 0x54) .....                          | 32        |
| 3.7.3    | AlarmMask1 (address 0x09) and AlarmMask2 (address 0x51) .....      | 33        |
| 3.7.4    | AlarmSet Register (address 0x0C).....                              | 34        |
| 3.7.5    | AlarmReset Register (address 0x0F) .....                           | 35        |
| 3.7.6    | Alarms Configuration Registers (Thresholds and Hold-Off Time)..... | 36        |

|          |                                                  |           |
|----------|--------------------------------------------------|-----------|
| 3.7.7    | Alarm Counter Registers .....                    | 37        |
| 3.8      | Command Register .....                           | 38        |
| 3.8.1    | General Settings .....                           | 38        |
| 3.8.2    | No Action (0x00xxxx) .....                       | 38        |
| 3.8.3    | Save to Flash Command (0xACC2xx) .....           | 39        |
| 3.8.4    | Clear Flash Storage 0 Command (0xACC0xx) .....   | 39        |
| 3.8.5    | Clear Flash Storage 1 Command (0xACC1xx) .....   | 39        |
| 3.8.6    | Calibration Command (0xCAxxxx) .....             | 40        |
| <b>4</b> | <b>Serial Interfaces .....</b>                   | <b>41</b> |
| 4.1      | UART Interface .....                             | 43        |
| 4.1.1    | Command-Response Protocol Description .....      | 44        |
| 4.1.2    | Auto-Reported Data .....                         | 47        |
| 4.2      | SPI Interface .....                              | 48        |
| 4.3      | I <sup>2</sup> C Interface .....                 | 51        |
| <b>5</b> | <b>Electrical Specifications .....</b>           | <b>55</b> |
| 5.1      | Absolute Maximum Ratings .....                   | 55        |
| 5.2      | Recommended External Components .....            | 55        |
| 5.3      | Recommended Operating Conditions .....           | 55        |
| 5.4      | Performance Specifications .....                 | 56        |
| 5.4.1    | Input Logic Levels .....                         | 56        |
| 5.4.2    | Output Logic Levels .....                        | 56        |
| 5.4.3    | Supply Current .....                             | 56        |
| 5.4.4    | Crystal Oscillator .....                         | 56        |
| 5.4.5    | Internal RC Oscillator .....                     | 56        |
| 5.4.6    | ADC Converter, V <sub>3P3</sub> Referenced ..... | 57        |
| 5.5      | Timing Specifications .....                      | 58        |
| 5.5.1    | RESET .....                                      | 58        |
| 5.5.2    | SPI Slave Port .....                             | 58        |
| 5.5.3    | I <sup>2</sup> C Slave Port .....                | 59        |
| <b>6</b> | <b>Packaging .....</b>                           | <b>60</b> |
| 6.1      | 24-Pin QFN Pinout .....                          | 60        |
| 6.2      | 16-Pin TSSOP Pinout .....                        | 61        |
| 6.3      | Package Outline .....                            | 62        |
| <b>7</b> | <b>Ordering Information .....</b>                | <b>64</b> |
| <b>8</b> | <b>Contact Information .....</b>                 | <b>64</b> |
|          | <b>Revision History .....</b>                    | <b>65</b> |

## List of Figures

|              |                                                                           |    |
|--------------|---------------------------------------------------------------------------|----|
| Figure 1-1:  | IC Functional Block Diagram .....                                         | 5  |
| Figure 1-2:  | XTAL Connection .....                                                     | 6  |
| Figure 1-3:  | RESET Pin Connections .....                                               | 7  |
| Figure 2-1:  | Analog Input Signal Conditioning .....                                    | 10 |
| Figure 2-2:  | HPF .....                                                                 | 10 |
| Figure 2-3:  | RMS Calculations .....                                                    | 11 |
| Figure 2-4:  | Power (Active, Reactive, and Apparent) and Power Factor Calculation ..... | 12 |
| Figure 2-5:  | Voltage and Current Fundamental and Harmonic Calculations .....           | 13 |
| Figure 2-6:  | Typical Measurement Location in Power Supplies .....                      | 15 |
| Figure 2-7:  | External Temperature Monitor .....                                        | 16 |
| Figure 2-8:  | Typical Sag Event .....                                                   | 17 |
| Figure 2-9:  | Relay Control for In-rush Current Limitation Circuitry .....              | 18 |
| Figure 2-10: | Relay Control .....                                                       | 19 |
| Figure 2-11: | Typical Calibration Setup .....                                           | 21 |
| Figure 4-1:  | UART Connections on a RS-485 Bus .....                                    | 43 |

|                                                                                                 |    |
|-------------------------------------------------------------------------------------------------|----|
| Figure 4-2: Signal Timing on the SPI Bus.....                                                   | 48 |
| Figure 4-3: Single Word Read Access Timing.....                                                 | 49 |
| Figure 4-4: Single Word Write Access Timing.....                                                | 50 |
| Figure 4-5: I <sup>2</sup> C Bus Connection in Standard (A) and Isolated (B) Configuration..... | 51 |
| Figure 4-6: I <sup>2</sup> C Bus 3-byte Data Write .....                                        | 53 |
| Figure 4-7: I <sup>2</sup> C Bus Multiple Sequential Register Write .....                       | 53 |
| Figure 5-1: SPI Slave Port Timing .....                                                         | 58 |
| Figure 5-2: I <sup>2</sup> C (Slave) Port Timing.....                                           | 59 |

## List of Tables

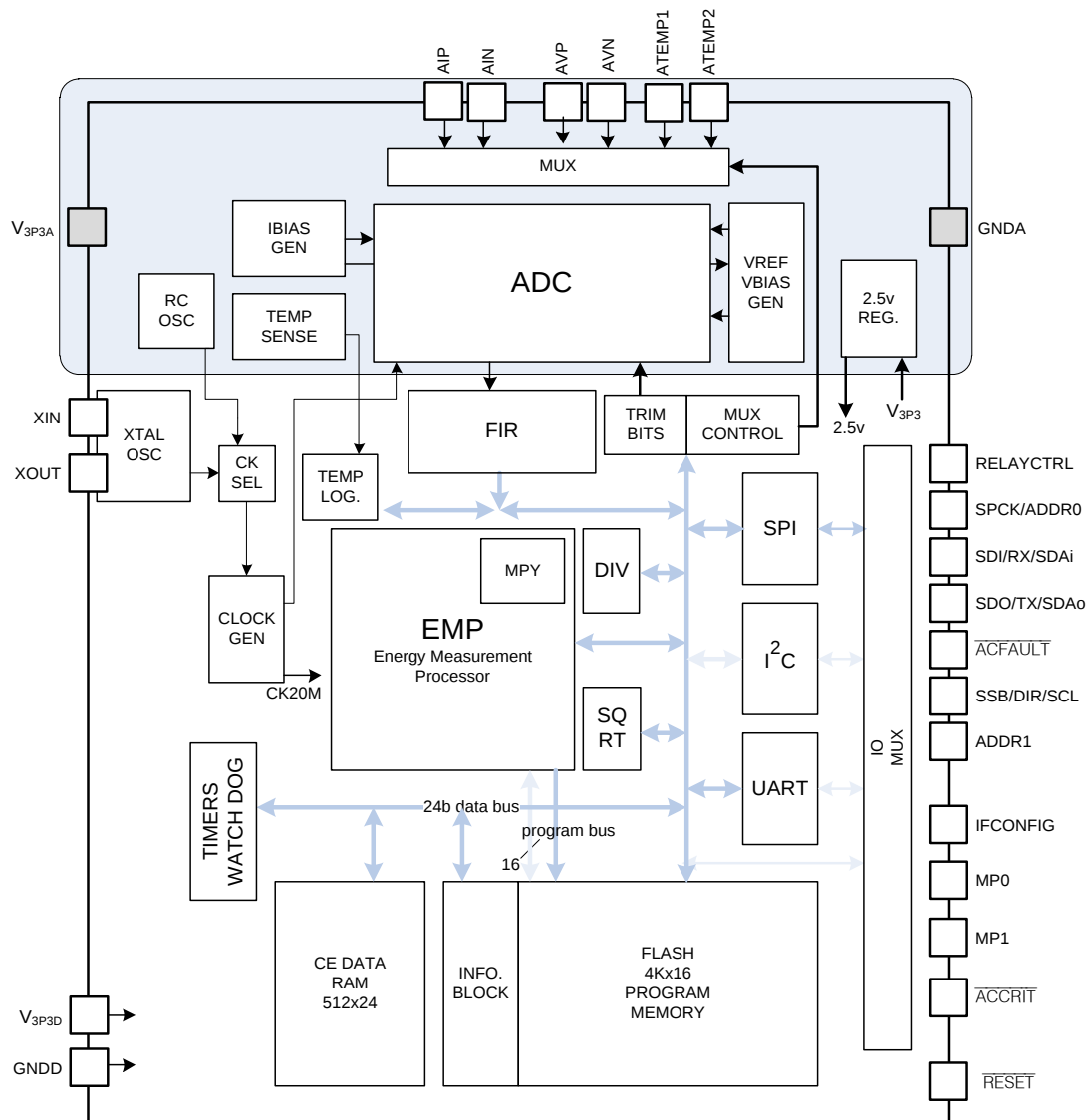
|                                                                           |    |
|---------------------------------------------------------------------------|----|
| Table 1-1: Alarm Pins Functional Description.....                         | 9  |
| Table 2-1: Relay Configuration Register and Sequence Delay Register.....  | 19 |
| Table 3-1: Data Type Description .....                                    | 23 |
| Table 3-2: Registers with Scalable Values .....                           | 24 |
| Table 3-3: Output Registers.....                                          | 25 |
| Table 3-4: High-Rate Result Registers .....                               | 26 |
| Table 3-5: Input Registers.....                                           | 27 |
| Table 3-6: Relay Configuration Registers .....                            | 29 |
| Table 3-7: DIOState Register.....                                         | 30 |
| Table 3-8: Alarms Register and Corresponding Configuration Registers..... | 31 |
| Table 3-9: AlarmSticky Register Bits Assignment .....                     | 32 |
| Table 3-10: AlarmMask1 and AlarmMask2 Registers Bits Assignment .....     | 33 |
| Table 3-11: AlarmSet Register Bit Assignments.....                        | 34 |
| Table 3-12: AlarmReset Registers Bit Assignments.....                     | 35 |
| Table 3-13: Alarms Threshold Registers .....                              | 36 |
| Table 3-14: Alarms Hold-Off Timers Registers.....                         | 37 |
| Table 3-15: Alarms Counter Registers.....                                 | 37 |
| Table 3-16: General Settings Command Bits .....                           | 38 |
| Table 3-17: No Action Command Bits.....                                   | 38 |
| Table 3-18: Save to Flash Command Bits .....                              | 39 |
| Table 3-19: Clear Flash Storage 0 Command Bits .....                      | 39 |
| Table 3-20: Clear Flash Storage 1 Command Bits .....                      | 39 |
| Table 3-21: Calibration Command Bits .....                                | 40 |
| Table 4-1: Host Commands .....                                            | 46 |
| Table 4-2: Slave Reply Codes .....                                        | 46 |
| Table 4-3: Default Measurements.....                                      | 47 |
| Table 4-4: Single Word SPI Read Command (SDI).....                        | 49 |
| Table 4-5: Single Word SPI Read Response (SDO) .....                      | 49 |
| Table 4-6: Single Word SPI Write Command and Data (SDI) .....             | 50 |
| Table 5-1: I <sup>2</sup> C Slave Port Timing <sup>2</sup> .....          | 59 |

# 1 On-Chip Resources Overview

The 78M6610+PSU integrates all the functional hardware blocks required to embed solid-state AC power and energy measurement. Included on the device are:

- Accurate oscillator and clock management logic
- Power-on reset, watchdog timer, and reset circuitry
- High-accuracy analog front-end (AFE) with trimmed voltage reference and temperature sensor
- 24-bit energy measurement processor (EMP)
- RAM and flash memory
- Communication interfaces
- Multipurpose Digital I/O

[Figure 1-1](#) shows a block diagram of the device. A detailed description of various functional blocks follows.



**Figure 1-1: IC Functional Block Diagram**

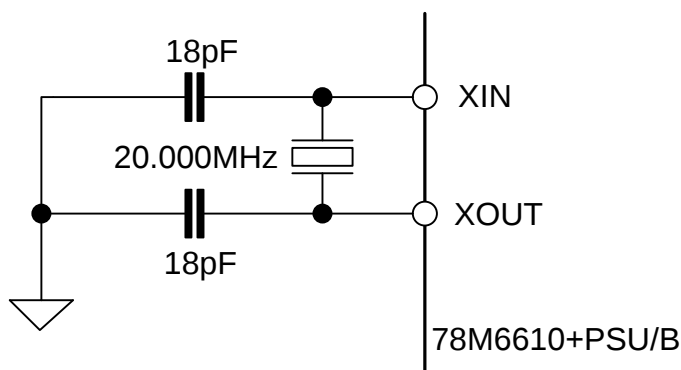
## 1.1 Clock Management

The 78M6610+PSU can be clocked by either the trimmed internal RC oscillator or by oscillator circuitry that relies on an external crystal. The 78M6610+PSU hardware automatically handles the clock sources logic and distributes the clock to the rest of the device.

Upon reset or power-on, the 78M6610+PSU will automatically select the external clock, if available, after 1024 clock cycles of the internal oscillator, allowing the external crystal adequate time to start up. After power-on or during run-time, the 78M6610+PSU will automatically switch to the internal oscillator in the event of a failure with the external oscillator (or crystal not mounted). This condition is also monitored by the processor and available to the user in the ALARMS register.

The internal RC oscillator is trimmed and temperature compensated. It provides an accurate clock source, however for applications requiring highest line frequency accuracy, the use of an external crystal is recommended (only available in the 24-pin QFN package).

The 78M6610+PSU external clock circuitry requires a 20.000MHz crystal. The circuitry includes two 18pF ceramic capacitors. [Figure 1-2](#) shows the typical connection of the external crystal. This oscillator is self-biasing and therefore an external resistor should NOT be connected across the crystal.



**Figure 1-2: XTAL Connection**

Alternatively, an external clock signal can be utilized instead of the crystal. In this case, the external clock should be connected to the XOUT pin while the XIN pin should be connected to GNDD.

If the external crystal is not utilized (not mounted), the XOUT pin should be connected to GNDD and the XIN pin left unconnected.

## 1.2 Power-On Reset, WD Timer, and Reset Circuitry

### Power-On Reset (POR)

An on-chip Power-On Reset (POR) block monitors the supply voltage ( $V_{3P3D}$ ) and initializes the internal digital circuitry at power-on. Once  $V_{3P3D}$  is above the minimum operating threshold, the POR circuit triggers and initiates a reset sequence. It will also issue a reset to the digital circuitry if the supply voltage falls below the minimum operating level.

### Watchdog Timer (WDT)

A Watchdog Timer (WDT) block detects any software processing errors. The embedded software periodically refreshes the free-running watchdog timer to prevent it from timing out. If the WDT times out, it is an indication that software is no longer being executed in the intended sequence; thus, a system reset is initiated.

### External Reset Pin ( $\overline{\text{RESET}}$ Pin)

The 24-pin QFN package provides a dedicated reset ( $\overline{\text{RESET}}$ ) pin. In addition to the internal sources, a reset can be forced by applying a low level to the  $\overline{\text{RESET}}$  pin.

If the  $\overline{\text{RESET}}$  pin is pulled low, all digital activities in the device stop, except the clock management circuitry and oscillators, which continue to run. The external reset input is filtered to prevent spurious reset events in noisy environments. The reset does not occur until  $\overline{\text{RESET}}$  has been held low for at least 1  $\mu\text{s}$ .

Once initiated, the reset mode persists until the  $\overline{\text{RESET}}$  is set high and the reset timer times out (4096 clock cycles). At the completion of the reset sequence, the internal reset is released and the processor (EMP) begins executing from address 0.

If not used, the  $\overline{\text{RESET}}$  pin can be connected either directly or through a pull-up resistor to  $V_{3P3D}$  supply. A simple connection diagram is shown in [Figure 1-3](#).

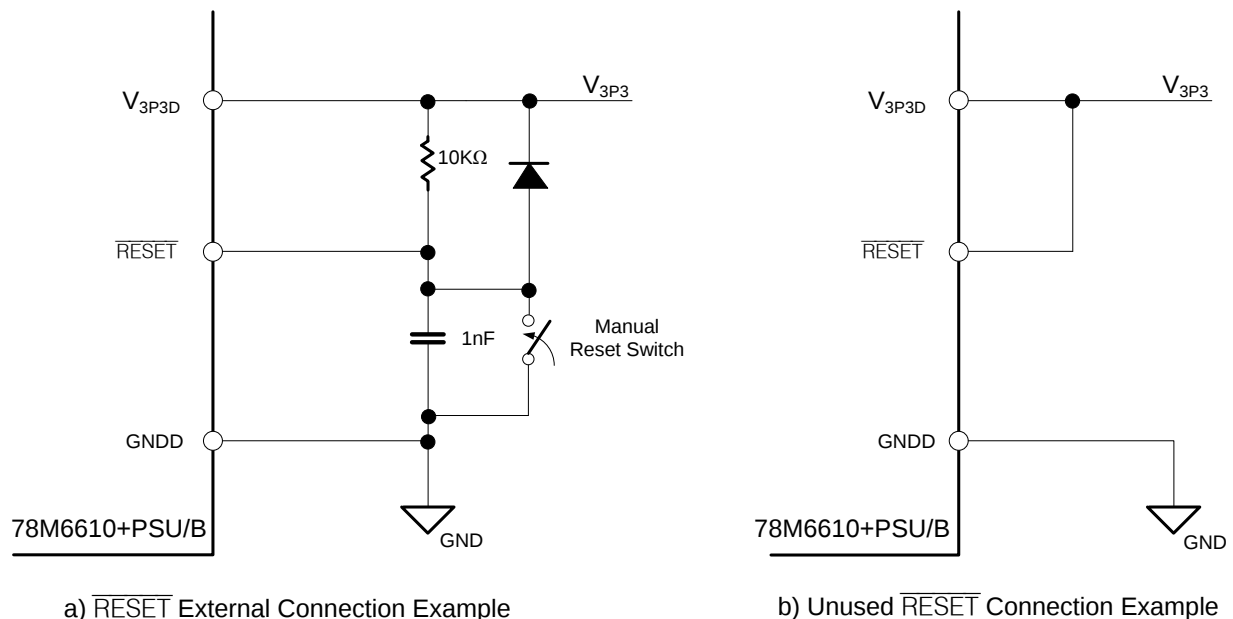


Figure 1-3:  $\overline{\text{RESET}}$  Pin Connections

### 1.3 Analog Front-End and Conversion

The Analog Front-End (AFE) of the 78M6610+PSU includes an input multiplexer, delta-sigma A/D converter, bias current references, voltage references, temperature sensor, and several voltage fault comparators.

#### Delta-Sigma A/D Converter

A second-order delta-sigma converter digitizes the analog inputs. The converted data is then processed through an FIR filter.

#### Voltage Reference

The device includes an on-chip precision bandgap voltage reference that incorporates auto-zero techniques as well as production trims to minimize errors caused by component mismatch and drift. The voltage reference is digitally compensated over temperature.

#### Die Temperature Measurement

The device includes an on-chip die temperature sensor used for digital compensation of the voltage reference. It is also used to report temperature information to the user.

#### Voltage and Current Inputs

The external voltage and current sensors are connected to differential voltage input pins. The full-scale signal level that can be applied to the voltage input pins is  $V_{3P3A} \pm 250$  mV. Considering a sinusoidal waveform, the maximum RMS voltage is:

$$V_{rmsMAX} = \frac{250mV}{\sqrt{2}} = 176.78mV$$

Although the voltage input is differential, a common-mode voltage of less than  $\pm 25$  mV is recommended in order to utilize the available dynamic range.

#### Temperature Inputs

ATEMP1 and ATEMP2 are single-ended inputs that allow temperature measurement through an external sensing element (NTC, RTD etc.). The temperature measurement is generally used to monitor heat-sink or exhaust air operating conditions. TEMP2 is only available with the 24-pin package option.

### 1.4 24-Bit Energy Measurement Processor (EMP)

The 78M6610+PSU integrates a dedicated 24-bit signal processor that performs all the digital signal processing necessary for energy measurement, alarm generation, calibration, compensation, etc. See [Section 2](#) for a description of functionality and operations.

### 1.5 Flash and RAM

The 78M6610+PSU includes 8KB of on-chip flash memory. The flash memory primarily contains program code, but also stores coefficients, calibration data, and configuration settings. The 78M6610+PSU includes 1.5KB of on-chip RAM which contains the values of input and output registers and is utilized by the FW for its operations.

### 1.6 Communication Peripherals

The 78M6610+PSU includes three communication interface options: UART, SPI, and I<sup>2</sup>C.

Since the I/O pins are shared, only one mode is supported at a time. Two pins are sampled at power-on or reset to determine which interface will be active.

## 1.7 Multi-Purpose Digital I/O Pins

The MP0 and MP1 input/output pins are not currently used. The pins have an internal pull-up and can be left floating.

## 1.8 Alarm Pins ( $\overline{\text{ACFAULT}}$ , $\overline{\text{ACCRIT}}$ )

Alarm pins are available to signal an alarm condition has been reached. [Table 1-1](#) shows the available alarm pins and the intended usage. The alarm thresholds and conditions are programmable through dedicated registers. The status of each individual alarm is accessible through a status register.

**Table 1-1: Alarm Pins Functional Description**

|                             |                                                                                     |
|-----------------------------|-------------------------------------------------------------------------------------|
| $\overline{\text{ACFAULT}}$ | Non critical warning updated once per accumulation interval.                        |
| $\overline{\text{ACCRIT}}$  | Critical condition detected; AC Dropout, or SAG (see <a href="#">Section 2.5</a> ). |

The alarm pins are open drain and active low (0=alarm). These pins need to be pulled up and can be wired-OR.

## 2 Functional Description and Operation

This section describes the 78M6610+PSU functionality. It includes measurements and relevant calculations, alarms, auxiliary functions such as calibrations, zero-crossing, relay control, etc.

A set of input (write), output (read) and read/write registers are provided to allow access to calculated data and alarms and to configure the device. The input (write) registers values can be saved into flash memory through a specific command. The values saved into flash memory will be loaded in these registers at reset or power-on as defaults.

### 2.1 Voltage and Current Inputs Conditioning

The sensor input voltages are digitized using a single integrated second-order delta-sigma A/D converter. The analog front-end includes a temperature sensor whose output is digitized and used for temperature (gain) compensation.

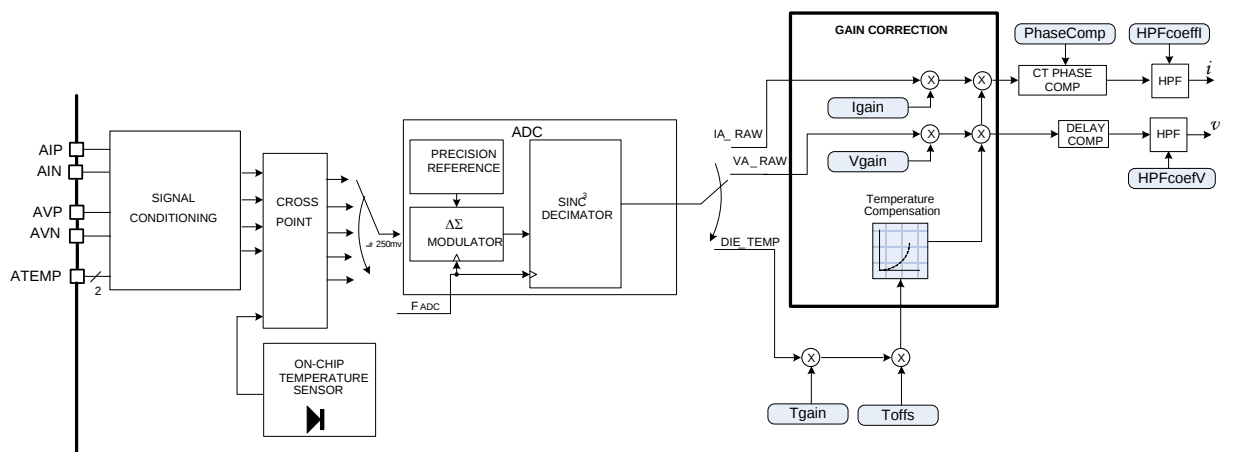


Figure 2-1: Analog Input Signal Conditioning

#### 2.1.1 High Pass Filters (HPF) and Offset Correction

The high-pass filters (HPF) in [Figure 2-1](#) and [Figure 2-2](#) can remove any DC from the signal paths and consequently from power and RMS calculated values. The HPFs work by subtracting the value of the offset register (Voffs, Ioffs) from the corresponding voltage or current input. The offset registers can be set by the user, by an automatic calibration routine or adjusted dynamically by the FW.

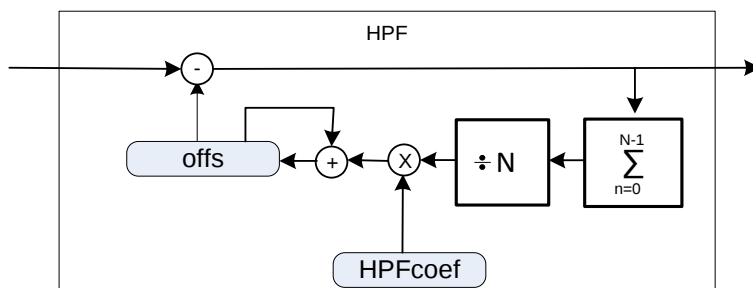


Figure 2-2: HPF

#### 2.1.2 Phase Compensation

A phase compensation register is provided to compensate phase errors introduced by current transformers (CT) or external filters. The amount of phase shift is set by the PhaseComp register as a fractional number of ADC samples with a total range of +/- 4 ADC samples (roughly +/- 20 degrees for a 60Hz line frequency).

## 2.2 Current and Voltage RMS Calculations

The 78M6610+PSU provides true RMS measurements for both current and voltage inputs. The RMS is obtained by performing the square sum of the instantaneous samples of voltage and current over a time interval (commonly referred as accumulation time) and then performing a square root of the result after dividing by the number of samples in the time interval.

$$VRMS = \sqrt{\frac{\sum_{n=0}^{N-1} Vn^2}{N}} \quad IRMS = \sqrt{\frac{\sum_{n=0}^{N-1} In^2}{N}}$$

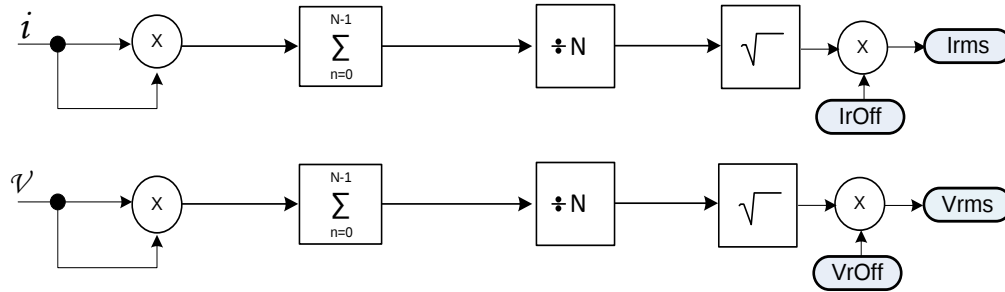


Figure 2-3: RMS Calculations

## 2.3 Power Calculations and Power Factor

The 78M6610+PSU computes the active, reactive, and apparent power. In addition, the 78M6610+PSU computes the fundamental power, determined only by the fundamental components of the voltage and current and the harmonic power, determined by the harmonic components of the voltage and current.

### 2.3.1 Active Power Calculation

Active power is calculated as the product of the voltage and current waveforms. The resulting waveform is the instantaneous power signal, and it is equal to the rate of energy flow at every instant of time. The unit of power is the watt or joules/sec. The instantaneous power is then averaged over N samples (accumulation time) for the computation of the active power available at register WATT.

$$WATT = \frac{\sum_{n=1}^{N-1} v_n i_n}{N}$$

### 2.3.2 Apparent Power

The apparent power (S) is the product of RMS voltage ( $V_{RMS}$ ) and current ( $I_{RMS}$ ). The apparent power results, also referred as Volt-Amps, are available at the register VA.

$$S = I_{RMS} * V_{RMS}$$

### 2.3.3 Power Factor

The power factor (PF) is calculated as active power (WATT) divided by the apparent power (S). The sign of the power factor is determined by the active power sign.

$$PF = \frac{WATT}{S}$$

### 2.3.4 Reactive Power

The reactive power is calculated as multiplication of instantaneous samples of current ( $i$ ) and the instantaneous quadrature voltage ( $V_q$ ). The quadrature voltage is obtained through a 90° phase shift (quadrature delay) of the voltage samples. The samples are then averaged over the accumulation time interval and updated in the VAR register.

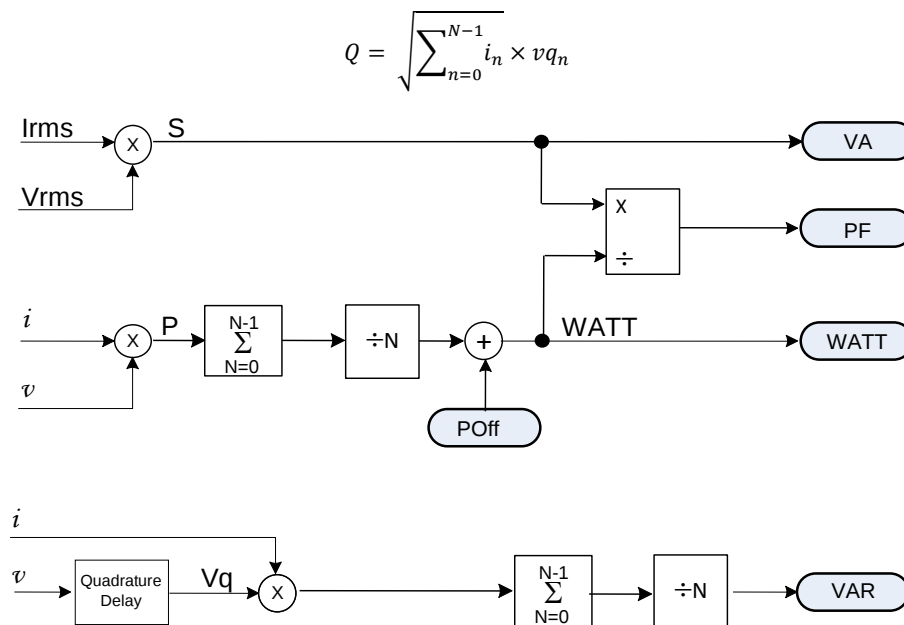


Figure 2-4: Power (Active, Reactive, and Apparent) and Power Factor Calculation

## 2.4 Fundamental and Harmonics Calculations

### Fundamental and Harmonics

The 78M6610+PSU provides measurements on fundamental and total harmonic of voltage, current, and power (active, reactive, and apparent).

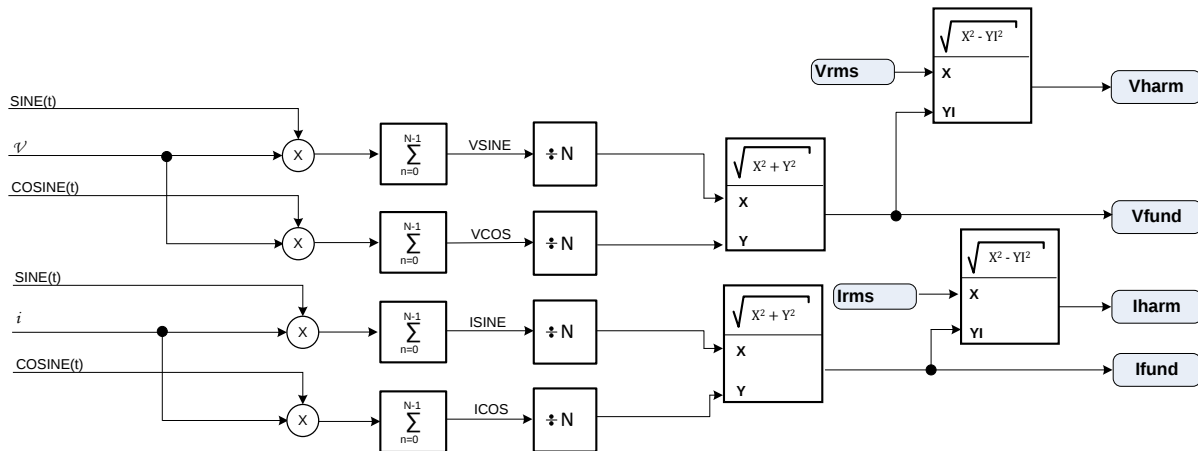


Figure 2-5: Voltage and Current Fundamental and Harmonic Calculations

### Fundamental and Harmonic Selection

The 78M6610+PSU allows extraction and calculation of a single selected harmonic. By default, the fundamental (first harmonic) is selected for voltage, current, active, reactive real and apparent power calculations. The HARM register is used to select the single harmonic to extract.

By setting the value in the HARM register to a higher harmonic, the fundamental result registers will contain amplitudes of the selected harmonic. In this case the harmonic result register will contain the balance of the voltage, current, or power.

## 2.5 Accumulation Interval

The accumulation interval mode is configurable by the user through the Accum and AccumCyc registers and the status of the line lock bit.

The ACCUM register contains an unsigned integer values representing the accumulation interval (time) expressed in number of high-rate samples.

The accumulation interval can also be locked to the incoming line voltage cycles. The LINELOCK bit in the command register allows the accumulation interval to be determined by the ACCUM register or to be locked to the line cycle.

Once locked to the line cycle the accumulation interval will end after the first low-to-high zero crossing of the Reference AC Voltage (see Zero-Crossing Detection) input occurs once the Minimum Accumulation time has elapsed. The Actual Accumulation Interval will span an integer number of line cycles. When LINELOCK is not set, the Accumulation Interval will equal the value set by the ACCUM register.

The effective sample rate for each input of the 78M6610+PSU is 4KS/s. The DIVISOR register reports the actual number of samples within any given accumulation interval.

It is also possible to set the accumulation interval based on a number of AC Voltage line cycles. If the Line Lock (LL) Command register bit is set and AccumCyc register is non-zero then the device will calculate, on every frequency update, a new Accum value based upon the line frequency. The formula is as follows:

$$Accum = \frac{SampleRate}{Line\ Frequency} - 18$$

**The computed Accum value locks the accumulation interval to the number of AC line voltage cycles, specified by the AccumCyc line cycles regardless of the system frequency.**

## 2.6 Zero-Crossing Detection

The 78M6610+PSU includes a zero-crossing detection feature on both AC input channels. The zero-crossing detection allows measurements to be synchronized to the frequency of the incoming waveforms. The time delay of the zero-crossing output versus the effective zero crossing is approximately 500  $\mu$ s.

## 2.7 Alarms

The 78M6610+PSU includes a set of user-configurable alarms. Most alarms have a corresponding register to store the threshold above which (in the case of “max” limits), or below which (in the case of “min” limits) an alarm condition is generated. Such a condition does not necessarily cause an alarm. The condition must exist for the duration of the associated hold-off time.

If the alarm condition exceeds the hold-off time, an alarm event is generated and reported in the corresponding bit of the alarm register. The corresponding event counter is also incremented.

The alarm bit will continue to be set as long as the alarm condition persists, even if the user clears it by accessing the AlarmReset register. However, event counters will only record one event until the next new assertion of the alarm.

The registers AlarmMask1 and AlarmMask2 allow the user to select which alarm will be used to drive the corresponding alarm pins (AlarmMask1 controls  $\overline{ACFAULT}$  pin while AlarmMask2 controls  $\overline{ACCRIT}$  pin). For example, to select OverCurrent and Vsurge to drive the  $\overline{ACFAULT}$  pin, AlarmMask1 should be set to 0x000440.

The AlarmSet register allows forcing a particular alarm in the alarm register. This function is mainly intended for relay control and system test purposes.

The AlarmReset register allows clearing a particular alarm in the alarm register.

The AlarmSticky register allows the user to select which bits in the alarm register should remain set even after the alarm condition no longer exists. These bits will remain set until reset by the host/user. All other Alarms will be reset at the end of the accumulation interval unless the alarm condition remains.

Exceptions: Relay\_On, Zero\_Cross, and Data\_Ready are not influenced by the value of the AlarmSticky register. By default, all the bits in the AlarmSticky register are set.

## 2.8 Voltage and Current Min/Max and Peak Tracking

### 2.8.1 Voltage and Current Min/Max Tracking

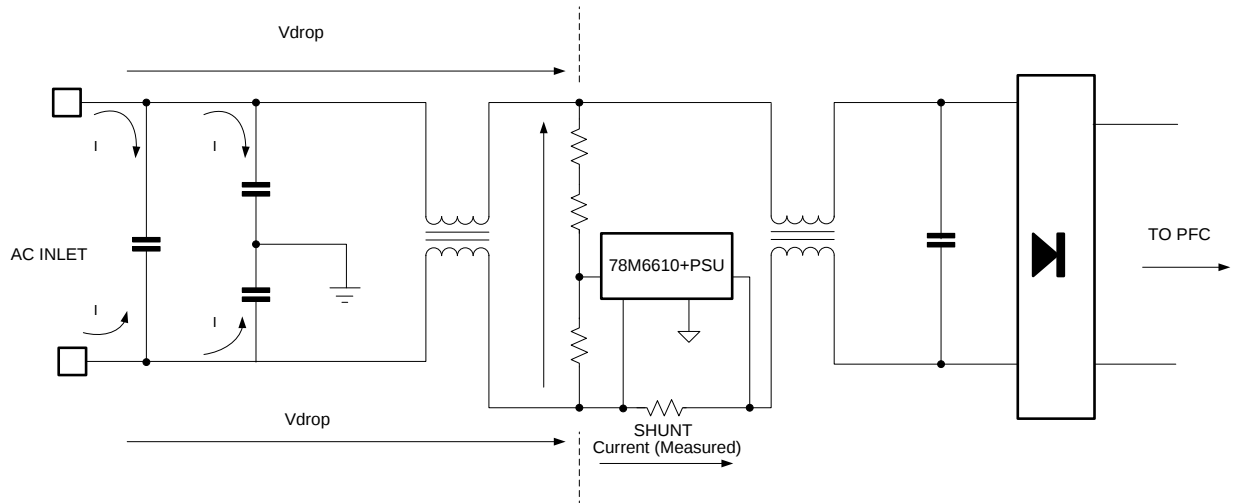
The 78M6610+PSU allows recording the lowest and highest voltage and current rms values. These values are stored in the registers Vhi, Vlo, Ihi, and Ilo. To reset these values it is necessary to write to these registers. For example, a value of 0x000000 should be written in the Vhi or Ihi register in order to reset them. Similarly, a value of 0x7FFFFFFF should be written to the Vlo and Ilo registers in order to reset them.

### 2.8.2 Voltage and Current Peak Tracking

The 78M6610+PSU allows recording the highest voltage and current measured during an accumulation interval. These values are updated at each accumulation interval and available on the output registers Vpeak and Ipeak, for voltage and current, respectively.

## 2.9 X+Y Capacitor Current and I/R Voltage Drop Compensation

The 78M6610+PSU location in the power supply AC input stage can be different from design to design. In order to achieve high accuracy, the components preceding the measurement point should be accounted for. For example, current flowing in filter capacitors or the voltage drop across PCB traces ( $I$ ,  $V_{drop}$ ) should be considered in the measurement as shown in [Figure 2-6](#).



**Figure 2-6: Typical Measurement Location in Power Supplies**

### 2.9.1 X+Y Capacitor Compensation

The 78M6610+PSU, and therefore the measurement point, is usually located between the inlet and the diode bridge. This stage is where the EMI filters are usually located as shown in [Figure 2-6](#).

In this case the current flowing through the filter (X+Y) capacitors preceding the measurement cannot be measured and is compensated for by the 78M6610+PSU. The current in flowing into these capacitors is at 90° phase respect to the voltage; therefore it has no effect on the power measurement. The effect is prominent in the current reading, in particular at light loads. Compensation is required in order to achieve higher accuracy.

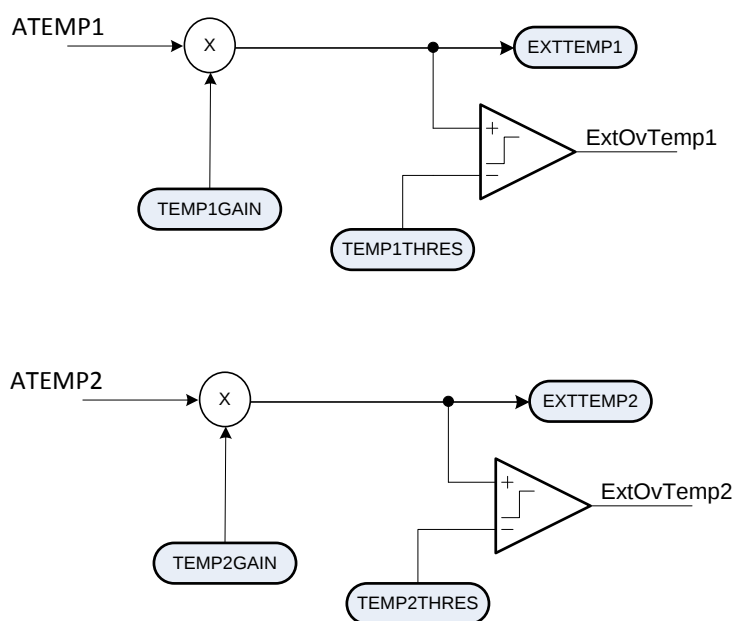
A fixed coefficient value can be set for compensation, however due to the tolerance of the filter capacitors (in the +/-20% range) a calibration routine is included in the firmware. Calibration of the X+Y capacitor coefficient facilitates higher accuracy in the measurement of the current

### 2.9.2 I/R Voltage Drop Compensation

The PCB traces have a certain resistance that at high loads causes a voltage drop from the inlet to the measurement point. The voltage drop causes an error in the voltage and power measurements. The correction is proportional to the current measured. A coefficient proportional to the input stage resistance is available and tunable by the user. Usually this coefficient is set by the user for a specific hardware and does not require calibration.

## 2.10 External Temperature Monitor

The ATEMP1 and ATEMP2 inputs are dedicated to the acquisition of an external temperature. These inputs are single ended with a range of  $\pm 250$  mV referenced to the 3.3VDC supply ( $V_{3P3A}$ ). The converted value is multiplied by a user programmable gain and the results are reported in the EXTTEMP registers as a voltage drop from  $V_{3P3}$ .



**Figure 2-7: External Temperature Monitor**

The output of the multiplier block is also compared with the value contained in a user-programmable register to generate a corresponding alarm once that limit value is exceeded.

## 2.11 Voltage Sag and Surge Detection

The 78M6610+PSU implements a voltage sag detection function, which can generate an alarm when the line voltage drops below a programmable threshold.

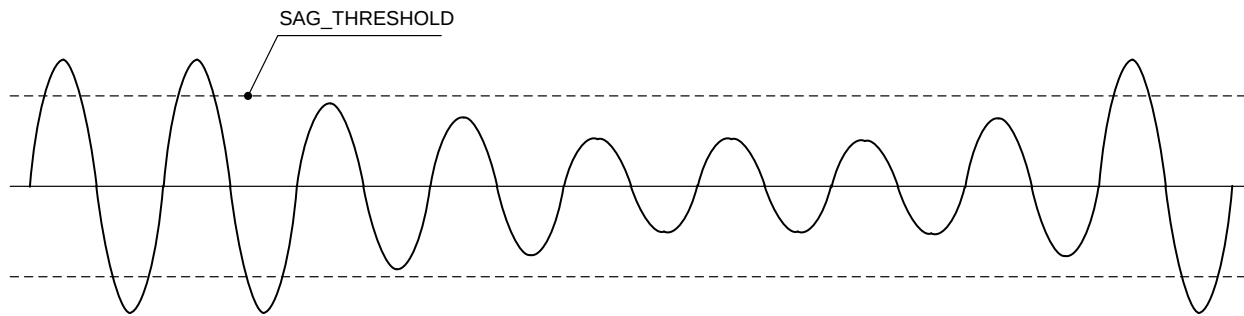
The firmware calculates on a sample-by-sample basis the trailing mean square of the input voltage:

$$V_{MS} = \frac{f_{line}}{2 \times f_{sample}} \times \sum_{n=-int(\frac{f_{sample}}{2 \times f_{line}})}^0 v_n^2$$

At each sample interval the  $V_{MS}$  value is compared to a programmable threshold contained in the Vsag register. If  $V_{MS}$  falls below the threshold, the firmware sets the Vsag bit in the Alarms register. If Vsag is enabled in the AlarmMask2 register, the  $\overline{ACCRI\overline{T}}$  pin will also be asserted low. If the Vsag bit is set in the AlarmsSticky register, then Alarms.Vsag will remain set and  $\overline{ACCRI\overline{T}}$  will remain low until the Vsag alarm is cleared via the AlarmReset register or the 78M6610+PSU is reset. If AlarmsSticky.Vsag is cleared, then Alarms.Vsag will be cleared and  $\overline{ACCRI\overline{T}}$  set high as soon as the  $V_{MS}$  monitor is greater than the programmable threshold.

The sample count for sag detection is automatically adjusted by the firmware to maintain coverage over half of the AC cycle. Sag detection is disabled by default and can be enabled by writing a non-zero value to the VSAG register. If the VSAG register is set to 0, the sag feature is disabled.

The sag detection can be used to monitor or record the quality of the power line or utilize the sag alarm pin to notify external devices (for example a host microprocessor) of a pending power-down. The external device can then enter a power-down mode (for example saving data or recording the event) before a Power outage. [Figure 2-8](#) shows a typical sag event.



**Figure 2-8: Typical Sag Event**

## 2.12 Relay Control

The firmware includes relay control logic and provides a digital output RELAYCTRL for controlling a relay.

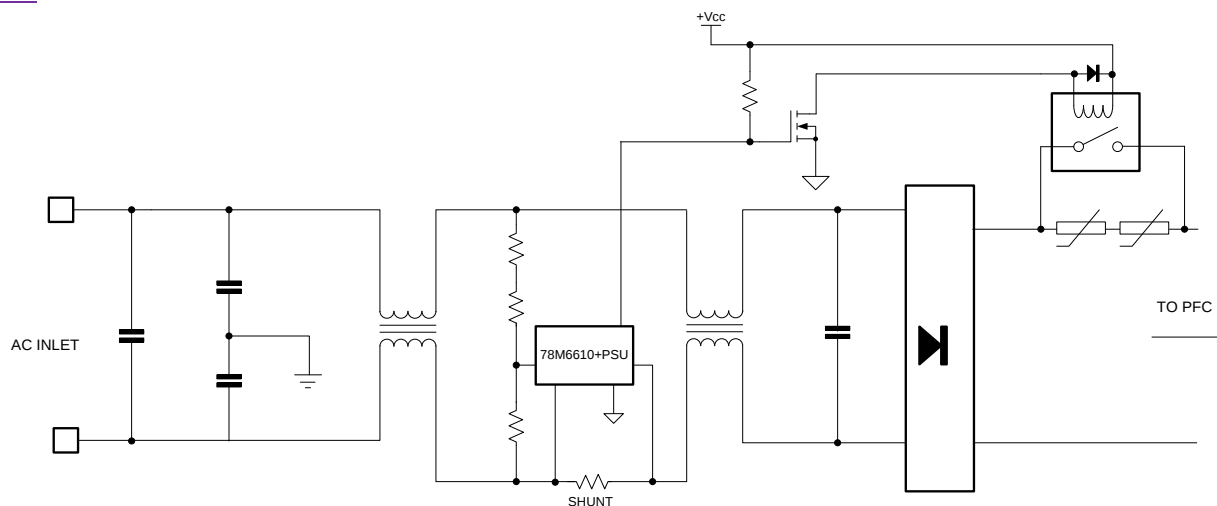
The relay control may operate in either an autonomous mode or in a slave mode. The operating mode is selected by the setting of the AUTORELAY bit in the COMMAND register. A bit in the ALARMS register reports the state of the RELAYCTRL output.

### 2.12.1 Autonomous Mode

When autonomous relay control mode is enabled, the 78M6610+PSU firmware controls the state of RELAYCTRL output, based upon the input line voltage.

At power on, RELAYCTRL output is inactive. When the RMS voltage is within specified upper and lower turn-on thresholds (RelayOnMin, RelayOnMax) for a specified time (RelayOnTime), RELAYCTRL output will be activated. Should the RMS voltage exceed the specified turn-off thresholds (RelayOffMin, RelayOffMax) for a specified time (RelayOffTime), RELAYCTRL output will be deactivated. The turn-on and turn-off thresholds are specified separately, as are delay times, to provide hysteresis to prevent unwanted switching of the relay due to short-term fluctuations in voltage.

The autonomous mode can be used to automatically control the in-rush current relay as shown in [Figure 2-9](#).



**Figure 2-9: Relay Control for In-rush Current Limitation Circuitry**

### 2.12.2 Slave Mode

When slave mode relay control is selected, the RELAYCTRL output is manually controlled by setting or clearing the RELAY\_ON bit in the AlarmSet and AlarmReset registers.

### 2.12.3 Activation Delay

The relay control logic allows setting a delay time for energizing and de-energizing the relay. The delay time for energizing and de-energizing the relay is relative to the zero crossing of the Voltage as shown in [Figure 2-10](#).

The time specified in the registers is expressed in the number of high-rate samples.

The default timings are:

|                                           |                        |
|-------------------------------------------|------------------------|
| Energized delay time (RelayOnDelay) =     | 0x000000 sample counts |
| De-Energized delay time (RelayOffDelay) = | 0x000000 sample counts |

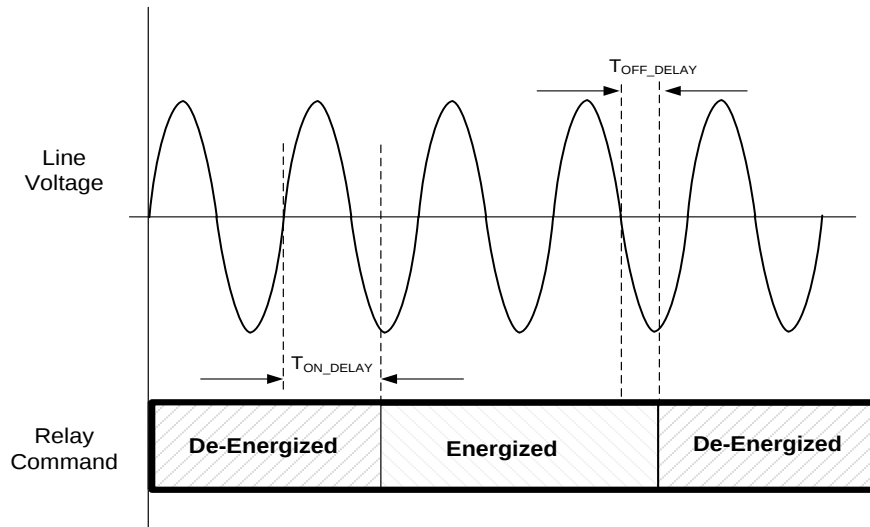


Figure 2-10: Relay Control

Table 2-1: Relay Configuration Register and Sequence Delay Register

| Function   | Register      |         | Default Value | Comments                            |
|------------|---------------|---------|---------------|-------------------------------------|
|            | Name          | Address |               |                                     |
| TON_Delay  | RelayOnDelay  | 0x6b    | 0             | Line Relay Activation Time Delay    |
| TOFF_Delay | RelayOffDelay | 0x6c    | 0             | Line Relay De-Activation Time Delay |

## 2.13 On-Chip Calibration Routines

The 78M6610+PSU includes current and voltage and temperature calibration routines. These routines modify gain and offset coefficients. The device also includes routines for the calibration of the X+Y capacitor and R resistance compensation coefficients.

The user can set and start a calibration routine through the Command register. When the calibration process completes, command register bits 23:16 (set to 0xCA to issue a calibration command) are cleared along with bits associated with channels that calibrated successfully. Any channels that failed will have their corresponding bit left set. After completion of the calibration, the new coefficients can be saved into flash memory as defaults by issuing the Save to Flash Command (0xACC2xx).

### 2.13.1 Voltage and Current Gain Calibration

In order to calibrate the voltage and current channels, a stable AC supply must be applied to the channel to be calibrated. The value corresponding to the applied AC supply (usually measured using a power meter) must be entered in the relevant target register (VTarget, ITarget). [Figure 2-11](#) shows a typical calibration setup.

To start the calibration, the calibration command must be written to the Command register.

Initially, the value of the gain is set to unity for the selected channels. RMS values are then calculated on all inputs and averaged over the number of measurement cycles set by the register CalCyc. The new gain is calculated by dividing the appropriate Target register value by the averaged measured value. The new gain is then written to the select Gain registers unless an error occurred.

On completion, the command bits are cleared in the Command register, leaving only the system setup bits. In case of a failed calibration, the corresponding bit in the command register is left set. During calibration, the line-lock mode should be set. Once completed, the calibration routines will store the new gain coefficients in the relevant registers. In order to save the new coefficients into flash memory as defaults, it is necessary to issue the Save to Flash Command (0xACC2xx).

### 2.13.2 Offset Calibration

The FW provide build in routines for calibration of the offset registers (Ioffs, Voffs).

To calibrate offset, all DC signals should be removed from all inputs although it is possible to do the calibration in the presence of AC signals. In the command, the user also specifies which channel(s) to calibrate. Target registers are not used for Offset calibration.

During the calibration process, each input is accumulated over the entire calibration interval as specified by the CalCycs register. The result is divided by the total number of samples and written to the appropriate offset register if selected in the calibration command. Using the Offset Calibration command will set the HPF coefficients (HPFcoefV, HPFcoefI) to zero thereby fixing the offset registers (Ioffs, Voffs) to their calibrated values. In order to save the new coefficients into flash memory as defaults, it is necessary to issue the Save to Flash Command (0xACC2xx).

### 2.13.3 X+Y Capacitor and R Compensation Coefficient Calibration

Most applications use a line input filter to minimize the EM emissions as shown in [Figure 2-11](#). The current in the filter capacitors (Icap) preceding the 78M6610+PSU cannot be measured. In order to obtain high accuracy of the current measurement it should be compounded in the total current (Irms) calculation.

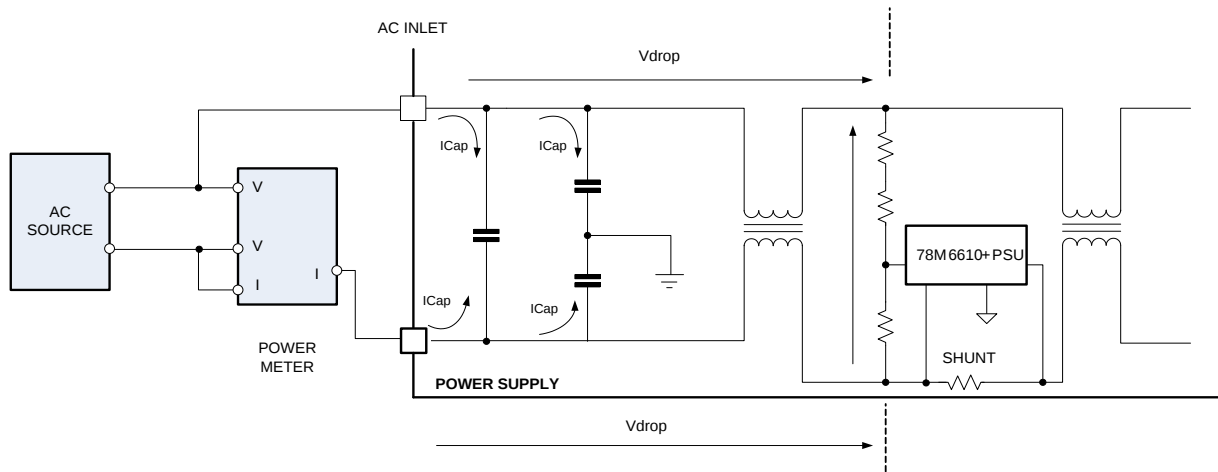
Fixed compensation coefficient values can be used, knowing the filter capacitors value. However due to the tolerance of the filter capacitors (often  $\pm 20\%$ ), in order to obtain higher accuracy in the current measurement, it could be required to utilize a specific coefficient for each system. The 78M6610+PSU provides a calibration routine for the X+Y capacitor compensation coefficient.

The routine X-Y compensation coefficient calibration, utilizes both measured voltage and frequency and the target current measured using an external power meter as in [Figure 2-11](#).

To start the command, the user writes the calibration command, setting bits XYR and I, and other needed options such as line-lock. On completion, the XYcomp parameter will be written with an estimate for the bulk capacitance. Once completed, the calibration routines will store the new gain coefficients in the relevant registers. During the calibration process, each input is accumulated over the entire calibration interval as specified by the CalCycs register.

This routine is not recursive; the user may need to re-issue the calibration command until the current reading matches the target current.

After completion of the calibration, in order to save the new coefficients into flash memory as defaults, it is necessary to issue the Save to Flash Command (0xACC2xx).



**Figure 2-11: Typical Calibration Setup**

#### 2.13.4 On-Chip Temperature Calibration

To calibrate the on-chip temperature sensor, the user must first write only the "T" command bit to a "1" (all other bits 0). This command prevents the firmware from overwriting TempC register. Next the user must write the known chip temperature to TempC. Finally the user writes the Calibration Command to 0xCA0400 (Calibrate Temperature). This will cause the Toffs parameter to be updated with a new offset based on the known temperature supplied by the user. In order to save the new coefficients into flash memory as defaults, it is necessary to issue the Save to Flash Command (0xACC2xx).

#### 2.13.5 External Temperature Calibration

To calibrate External Temperature, the user must first write only the "X" command bit to a "1" (all other bits 0). This prevents the firmware from overwriting ExtTemp. Next the user must write the known external temperature reading to ExtTemp. Finally the user writes the Calibration Command to 0xCA0100 (Calibrate External Temperature). This will cause the Xgain parameter to be updated with a new gain based on the known external temperature value supplied by the user. In order to save the new coefficients into flash memory as defaults, it is necessary to issue the Save to Flash Command (0xACC2xx).

### 3 Data Access and Configurability

The 78M6610+PSU has several user accessible registers that are used for configuring the device and to access results data. These registers are read (output), write (input), or read/write type, such as the Command register. These registers are accessible through the serial interfaces available on-chip (UART, SPI, and I<sup>2</sup>C).

#### Warning

**Writing to reserved registers or to unspecified memory locations could result in malfunctions or unexpected results.**

#### Note

**The documented address locations apply to the UART interface. For SPI or I<sup>2</sup>C addressing, one must divide the address by 3.**

#### 3.1 Register Descriptions

##### Data Types

The input and output registers have different data types, depending on their assignment and functions. [Table 3-1](#) shows the different data types.

The notation used indicates whether the number is signed, unsigned, or bit-mapped and the location of the binary point.

- U Indicates an unsigned value.
- S Indicates a signed value.
- . If present, indicates a fixed point number
- nn If to the right of the decimal, indicates the number of bits to the right of the binary point.  
If no decimal is present, indicates the total bits in the number.

Example: S.21

| Bit Position        |                |                |   |                 |                 |                 |                 |     |                  |                  |                  |
|---------------------|----------------|----------------|---|-----------------|-----------------|-----------------|-----------------|-----|------------------|------------------|------------------|
| 23                  | 22             | 21             | . | 20              | 19              | 18              | 17              | ... | 2                | 1                | 0                |
| S(-2 <sup>2</sup> ) | 2 <sup>1</sup> | 2 <sup>0</sup> |   | 2 <sup>-1</sup> | 2 <sup>-2</sup> | 2 <sup>-3</sup> | 2 <sup>-4</sup> | ... | 2 <sup>-19</sup> | 2 <sup>-20</sup> | 2 <sup>-21</sup> |

**Table 3-1: Data Type Description**

| <b>Data Type</b> | <b>Description</b>                                                                                                       |
|------------------|--------------------------------------------------------------------------------------------------------------------------|
| UINT24           | A 24-bit unsigned integer having a range of 0 to 16777215. Typically used for counters                                   |
| INT24            | A 24-bit signed integer with a range of -8388608 to +8388607.                                                            |
| USI24            | A 24-bit unsigned scaled integer (scaled by the user).                                                                   |
| SSI24            | A 24-bit signed scaled integer (scaled by the user).                                                                     |
| U.24             | A 24-bit unsigned fixed-point value with the binary point to the left of bit 23 with a range of 0 to $1-2^{-24}$ .       |
| U.23             | A 24-bit unsigned fixed-point number with the binary point to the left of bit 22 and with a range of 0 to $1-2^{-23}$ .  |
| U.22             | A 24-bit unsigned fixed-point number with the binary point to the left of bit 21 and with a range of 0 to $2-2^{-22}$ .  |
| U.21             | A 24-bit unsigned fixed point number with the binary point to the left of bit 20 and with a range of 0 to $4-2^{-21}$ .  |
| S.23             | A 24-bit signed fixed point number with the binary point to the left of bit 22 and with a range of -1.0 to $1-2^{-23}$ . |
| S.21             | A 24-bit signed fixed-point number with a binary point to the left of bit 20 and with a range of -4.0 to $4-2^{-21}$ .   |
| S.16             | A 24-bit signed fixed-point number with a binary point to the left of bit 16 and with a range of -128 to +128            |
| Boolean (B24)    | A variable containing 24 independent single-bit values.                                                                  |

### 3.2 Scaling Registers (Iscale, Vscale, Pscale, Tscale, Fscale)

The scaling registers can be used to set the full-scale values and choosing the resolution of related parameters and results.

For voltage and current inputs, full scale is defined as +/-250 mV (DC or Peak). The voltage input is usually scaled down from the AC inlet using a sensing element: resistor divider, voltage transformer, etc.

The current input is connected to current sensing element, generally a low value resistive shunt or current transformer (CT).

The Iscale and Vscale parameters need to be set in order to match the full scale range of the current and voltage inputs with the full scale range of the sensor.

#### Examples

**Voltage:** A voltage divider produces an output of 250 mV (peak) with 230 V (peak) applied at its input. A resolution of 1 mV is needed. In this case, the value of VSCALE register should be:

$$VSCALE = 230 * 1000 = 230000$$

**Current:** A current shunt produces a voltage drop of 250 mV (peak) at 30 A (peak). A resolution of 1 mA is needed. In this case the value of ISCALE register should be:

$$ISCALE = 30 * 1000 = 30000$$

**Power:** To set the power scaling register PSCALE it is necessary to multiply the full-scale voltage by the full-scale current and by the desired resolution. For 1 mW resolution:

$$PSCALE: 230 \text{ volts} \times 30 \text{ amps} \times 1000 = 6900000 \text{ mw. The value of Pscale register should be set to } 6900000.$$

The scaling registers for Line Frequency, Power Factor, and Temperature do not set full scale values. They only set resolution. For example, setting Tscale to 1000 the value of the temperature is represented in 1/1000 of Degree Celsius. For example, by setting the Tscale register to 1000, a temperature of 27°C is reported as 27000 in the Temperature register.

#### Note

**All 78M6610+PSU registers are 24 bits and most are signed. The largest signed integer is +/- 8388608. In case of larger numbers, a lower resolution must be chosen. For example, 10 mW versus 1 mW is case of PSCALE register.**

**Table 3-2: Registers with Scalable Values**

| Scaling Register | Registers Affected by Scaling                                                                                       |
|------------------|---------------------------------------------------------------------------------------------------------------------|
| Iscale           | Irms Ifund Iharm Ihi Ilo Ipeak Imax Itarget                                                                         |
| Vscale           | Vrms Vfund Vharm Vhi Vlo Vpeak Vsurge Vsag Vdrop Vmin Vmax Vtarget<br>RelayOnMin RelayOnMax RelayOffMin RelayOffMax |
| Pscale           | Power VA VAR Paverage Pfund Pharm Qfund Qharm Pmax                                                                  |
| PFscale          | PF                                                                                                                  |
| Tscale           | Temperature Tmin Tmax Xtemperature Xmin Xmax                                                                        |
| Fscale           | Frequency Fmin Fmax                                                                                                 |

### 3.3 Output Registers

The output registers provide access to the measurement results. Unless otherwise specified, these registers are read-only. Divide the address by 3 for I<sup>2</sup>C or SPI access.

**Table 3-3: Output Registers**

| Address (Hex) | Variable Name | Data Type | Description                                                                     |
|---------------|---------------|-----------|---------------------------------------------------------------------------------|
| 0x00          | Command       | B24       | Command Register (see <a href="#">Command Register</a> Section)                 |
| 0x03          | FW version    | UINT24    | Firmware release date in hex format (0x00YMDD)                                  |
| 0x12          | Temperature   | S.16      | Chip Temperature (-128°C to +128°C, binary point to left of bit 16)             |
| 0x15          | VA            | SSI24     | Apparent Power (LSB weight determined by Pscale)                                |
| 0x18          | VAR           | SSI24     | Reactive Power (LSB weight determined by Pscale)                                |
| 0x1B          | Vrms          | USI24     | RMS Voltage (LSB weight determined by Vscale)                                   |
| 0x1E          | Irms          | USI24     | RMS Current (LSB weight determined by Iscale)                                   |
| 0x21          | Watt          | SSI24     | Active Power (LSB weight determined by Pscale)                                  |
| 0x24          | PAverage      | SSI24     | Active Power Averaged over 30s Window (LSB determined by Pscale)                |
| 0x27          | PF            | SSI24     | Power Factor (LSB weight determined by PFscale)                                 |
| 0x2A          | Frequency     | USI24     | Line Frequency (LSB weight determined by Fscale)                                |
| 0x30          | Alarms        | B24       | Alarm Status Registers                                                          |
| 0x33          | Vfund         | USI24     | RMS Voltage (Fundamental) (LSB weight determined by Vscale)                     |
| 0x36          | Ifund         | USI24     | RMS Current (Fundamental) (LSB weight determined by Iscale)                     |
| 0x39          | Pfund         | SSI24     | Active Power (Fundamental) (LSB weight determined by Pscale)                    |
| 0x3C          | Qfund         | SSI24     | Reactive Power (Fundamental) (LSB weight determined by Pscale)                  |
| 0x3F          | VAfund        | SSI24     | Apparent Power (Fundamental) (LSB weight determined by Pscale)                  |
| 0x42          | Vharm         | USI24     | RMS Voltage (Harmonic) (LSB weight determined by Vscale)                        |
| 0x45          | Iharm         | USI24     | RMS Current (Harmonic) (LSB weight determined by Iscale)                        |
| 0x48          | Pharm         | SSI24     | Active Power (Harmonic) (LSB weight determined by Pscale)                       |
| 0x4B          | Qharm         | SSI24     | Reactive Power (Harmonic) (LSB weight determined by Pscale)                     |
| 0x4E          | VAharm        | SSI24     | Apparent Power (Harmonic) (LSB weight determined by Pscale)                     |
| 0x57          | ILow          | USI24     | Lowest RMS Current Recorded Since Reset (LSB determined by Iscale)              |
| 0x5A          | IHigh         | USI24     | Highest RMS Current Recorded Since Reset (LSB determined by Iscale)             |
| 0x5D          | Ipeak         | USI24     | Highest Current in Last Accumulation Interval (LSB determined by Iscale)        |
| 0x60          | VLow          | USI24     | Lowest RMS Voltage Recorded Since Reset (LSB determined by Vscale)              |
| 0x63          | VHigh         | USI24     | Highest RMS Voltage Recorded Since Reset (LSB weight determined by Vscale)      |
| 0x66          | Vpeak         | USI24     | Highest Voltage in Last Accumulation Interval (LSB weight determined by Vscale) |
| 0xA8:C9       | —             | UINT24    | Event Counters for Alarms                                                       |

| Address (Hex) | Variable Name | Data Type | Description                                       |
|---------------|---------------|-----------|---------------------------------------------------|
| 0xD5          | ExtTemp1      | USI24     | External Temperature 1 (ATEMP1 Input)             |
| 0xD8          | ExtTemp2      | USI24     | External Temperature 2 (ATEMP2 Input)             |
| 0x10E         | Divisor       | UINT24    | Actual Accumulation Interval for Low Rate Results |
| 0x147         | DIOState      | B24       | State of DIO Outputs                              |
| 0x156         | Irms1         | UINT24    | Unscaled RMS Current                              |
| 0x159         | Vrms1         | UINT24    | Unscaled RMS Voltage                              |
| 0x15C         | Power1        | INT24     | Unscaled Active Power                             |
| 0x15F         | Var1          | INT24     | Unscaled Reactive Power                           |
| 0x162         | VA1           | INT24     | Unscaled Apparent Power                           |
| 0x165         | PF1           | INT24     | Unscaled Power Factor                             |
| 0x168         | Freq1         | UINT24    | Unscaled Frequency                                |

### High-Rate Result (Output Registers)

These output registers contain the instantaneous values of voltage, current, power and quadrature power. The high-rate registers are updated at the ADC Sampling Frequency (4.0 kHz). These register, given the relatively high update rate, should be accessed with a high speed interface such as SPI.

**Table 3-4: High-Rate Result Registers**

| Address (Hex) | Variable Name         | Data Type | Description                  |
|---------------|-----------------------|-----------|------------------------------|
| 0x16B         | V <sup>(1)</sup>      | INT24     | High-Rate Voltage            |
| 0x16E         | I <sup>(1)</sup>      | INT24     | High-Rate Current            |
| 0x171         | Vq <sup>(1)</sup>     | INT24     | High-Rate Quadrature Voltage |
| 0x174         | P <sup>(1)</sup>      | INT24     | High-Rate Power              |
| 0x177         | PQ <sup>(1)</sup>     | INT24     | High-Rate Quadrature Power   |
| 0x17A         | Cycle <sup>(1)</sup>  | UINT24    | High-Rate Samples            |
| 0x17D         | Scycle <sup>(1)</sup> | UINT24    | High-Rate Sag/Surge Cycles   |

Note:

- 1) The high rate registers are updated at the ADC converter sample rate. In order to access real time data it is preferable to utilize the SPI interface.

### 3.4 Input Registers (Setup and Calibration)

Input Registers are used to configure the device, issue commands etc. The input registers content can be saved to flash memory the values restored as defaults upon power-on or reset.

**Table 3-5: Input Registers**

| Address (Hex) | Variable Name | Data Type | Flash Saved | Description                                                        | Default (Decimal) |
|---------------|---------------|-----------|-------------|--------------------------------------------------------------------|-------------------|
| 0x00          | Command       | B24       | Y           | Command Register (see <a href="#">Command Register Section</a> )   |                   |
| 0x06          | PhaseComp     | S.21      | Y           | Phase Compensation (High-Rate Samples)                             | 0                 |
| 0x09          | Alarm_Mask1   | B24       | Y           | Alarm Mask Bits for $\overline{\text{ACFAULT}}$ Pin                |                   |
| 0x0C          | Alarm_Set     | B24       | Y           | Sets Corresponding Alarm Bits                                      |                   |
| 0x0F          | Alarm_Reset   | B24       | Y           | Clears Corresponding Alarm Bits                                    |                   |
| 0x2D          | DevAddr       | UINT24    | Y           | UART (MultiPoint) and I <sup>2</sup> C Address                     | 0                 |
| 0x51          | Alarm_Mask2   | B24       | Y           | Alarm Mask Bits for $\overline{\text{ACCRIT}}$ Pin                 |                   |
| 0x54          | Sticky        | B24       | Y           | Alarm Bits to Control Auto-Reset of Alarm Status                   |                   |
| 0x69:8D       | –             | –         | Y           | Alarm Limit Registers (See <a href="#">Section 3.6</a> )           |                   |
| 0x90:A2       | –             | –         | Y           | Alarm Hold-Off Time Registers (See <a href="#">Section 3.6</a> )   |                   |
| 0xA5          | IrOff         | U.23      | Y           | RMS Current Offset Adjust                                          |                   |
| 0xA8          | VrOff         | U.23      | Y           | RMS Voltage Offset Adjust                                          |                   |
| 0xAB          | POff          | U.23      | Y           | Power Offset Adjust                                                |                   |
| 0xCC          | AccumCyc      | UINT24    | Y           | Number of Line Cycles for Low Rate                                 |                   |
| 0xCF          | Ptarget       | UINT24    | Y           | Current Gain Calibration, Power Target                             | 0                 |
| 0xD2          | Baud          | UINT24    | Y           | UART Baud Rate                                                     | 38,400            |
| 0xDB          | Temp1Gain     | UINT24    | Y           | External Temperature Gain                                          | 0                 |
| 0xDE          | Temp2Gain     | UINT24    | Y           | External Temperature Gain                                          | 0                 |
| 0xE1          | HPFCoeffI     | U.23      | Y           | Current Offset Removal Settling Time                               | 1                 |
| 0xE4          | HPFCoeffV     | U.23      | Y           | Voltage Offset Removal Settling Time                               | 1                 |
| 0xE7          | Itarget       | UINT24    | Y           | Current Gain Calibration, Current Target                           | 128,000           |
| 0xEA          | Vtarget       | UINT24    | Y           | Voltage Gain Calibration, Voltage Target                           | 120,000           |
| 0xED          | CalCyc        | UINT24    | Y           | Number of Calibration Cycles to Average                            | 5                 |
| 0xF0          | Igain         | U.21      | Y           | Current Gain Setting (Updated After Calibration)<br>Range 0 to 4   | 1                 |
| 0xF3          | Vgain         | U.21      | Y           | Voltage Gain Setting (Updated After Calibration)                   | 1                 |
| 0xF6          | Ioff          | S.23      | Y           | Current Offset (Updated After Calibration)                         | N/A               |
| 0xF9          | Voff          | S.23      | Y           | Voltage Offset (Updated After Calibration)                         | N/A               |
| 0xFC          | Tgain         | U.24      | Y           | Die Temperature Gain Setting (Updated After Calibration)           | 701,233           |
| 0xFF          | Toffs         | U.24      | Y           | Die Temperature Offset (Updated After Calibration)                 | 287,831           |
| 0x102         | SysGain       | S.23      | N           | Temperature Compensated System Gain<br>(Updated After Calibration) | N/A               |
| 0x105         | Harm          | UINT24    | N           | Harmonic Selector                                                  | 1                 |

| Address (Hex) | Variable Name | Data Type | Flash Saved | Description                                                      | Default (Decimal) |
|---------------|---------------|-----------|-------------|------------------------------------------------------------------|-------------------|
| 0x108         | Saccum        | UINT24    | N           | Accumulation Interval for Sag and Surge                          | 40                |
| 0x10B         | Accum         | UINT24    | Y           | Accumulation Interval for Calculation (RMS, etc.)                | 400               |
| 0x111         | Frame         | UINT48    | N           | Low Rate Frame Number Counter                                    | N/A               |
| 0x117         | XYcomp        | UINT24    | Y           | Line Filters Capacitive Compensation                             | 0                 |
| 0x11A         | Rcomp         | UINT24    | Y           | Resistive I/R Drop Compensation                                  | 0                 |
| 0x11D         | Iscale        | UINT24    | Y           | Current Scaling Register                                         | 30,000            |
| 0x120         | Vscale        | UINT24    | Y           | Voltage Scaling Register                                         | 30,000            |
| 0x123         | Pscale        | UINT24    | Y           | Power Scaling Register                                           | 6,900,000         |
| 0x126         | PFscale       | UINT24    | Y           | Power Factor Scaling Register                                    | 1000              |
| 0x129         | Fscale        | UINT24    | Y           | Frequency Scaling Register                                       | 1000              |
| 0x12C         | Tscale        | UINT24    | Y           | Temperature Scaling Register                                     | 1000              |
| 0x12F:144     | –             | UINT24    | Y           | Relay Configuration Registers (See <a href="#">Section 3.5</a> ) |                   |
| 0x14A         | TC1           | UINT24    | Y           | Temperature Compensation                                         | 0                 |
| 0x14D         | TC2           | UINT24    | Y           | Temperature Compensation                                         | 0                 |
| 0x147         | RESERVED      | B24       | N           | Read-Only Register                                               | N/A               |

### 3.5 Relay Configuration

The registers in [Table 3-6](#) are used to configure the relay operations.

**Table 3-6: Relay Configuration Registers**

| Address | Register      | Format | Flash Saved | Description                                                         | Default (Decimal) |
|---------|---------------|--------|-------------|---------------------------------------------------------------------|-------------------|
| 0x12F   | RelayOnMin    | UINT24 | Y           | Minimum Voltage to Keep Relay ON (LSB weight determined by Vscale)  | 85,000            |
| 0x132   | RelayOnMax    | UINT24 | Y           | Maximum Voltage to Keep Relay ON (LSB weight determined by Vscale)  | 255,000           |
| 0x135   | RelayOnTime   | UINT24 | Y           | Hold ON Time (Samples) If Min/Max Not Met                           | 4                 |
| 0x138   | RelayOffMin   | UINT24 | Y           | Minimum Voltage to Keep Relay OFF (LSB weight determined by Vscale) | 90,000            |
| 0x13B   | RelayOffMax   | UINT24 | Y           | Maximum Voltage to Keep Relay OFF (LSB weight determined by Vscale) | 250,000           |
| 0x13E   | RelayOffTime  | UINT24 | Y           | Hold OFF Time (Samples) If Min/Max Met                              | 4                 |
| 0x141   | RelayOnDelay  | UINT24 | Y           | Relay Closure Time (ms)                                             | 0                 |
| 0x144   | RelayOffDelay | UINT24 | Y           | Relay Opening Time (ms)                                             | 0                 |

### 3.6 DIOState Register

The DIOState register reports the state of the digital input/output pins. Unconnected or floating pins are reported as set as one. [Table 3-7](#) lists the bit assignments.

**Table 3-7: DIOState Register**

| Bit   | Pin Status              | Function                                                       |
|-------|-------------------------|----------------------------------------------------------------|
| 23-11 | N/A                     | N/A                                                            |
| 10    | MP1                     | Multi-Purpose Digital I/O                                      |
| 9     | MP0                     | Multi-Purpose Digital I/O                                      |
| 8     | IFCONFIG                | UART/I <sup>2</sup> C/SPI Selection                            |
| 7     | ACFAULT                 | ACFAULT Alarm                                                  |
| 6     | ADDR1                   | I <sup>2</sup> C/Multi-Point UART Address                      |
| 5     | SSB/DIR/SCL             | Slave Select (SPI) / RS485 TX-RX/I <sup>2</sup> C Serial Clock |
| 4     | ACCRIT                  | AC Input Voltage Alarm (Critical)                              |
| 3     | SDO/TX/SDA <sub>0</sub> | SPI DATA OUT/UART TX/I <sup>2</sup> C Data Out                 |
| 2     | SDI/RX/SDA <sub>i</sub> | SPI DATA IN/UART RX/I <sup>2</sup> C Data In                   |
| 1     | SCK/ADDR0               | SPI CLOCK IN/I <sup>2</sup> C/Multi-Point UART Address         |
| 0     | RELAYCTRL               | Relay Control Output                                           |

### 3.7 Alarms and Alarms Configuration Registers

#### 3.7.1 Alarms Status Register (address 0x30)

The Alarms Status register is an output register (read-only) that contains the status of the alarms and other conditions. [Table 3-8](#) reports the Alarms register bit assignment and the corresponding limit registers (thresholds) and Hold-Off time registers.

**Table 3-8: Alarms Register and Corresponding Configuration Registers**

| Bit   | Alarms Register (Bit) | Limit Register <sup>(1)</sup> | Hold-Off Register <sup>(1)</sup> | Function                                                 |
|-------|-----------------------|-------------------------------|----------------------------------|----------------------------------------------------------|
| 23    | DataReady             | –                             | –                                | Low-rate results have been updated                       |
| 22    | OverTemp              | Tmax                          | TminHold                         | Die temperature is over limit                            |
| 21    | UnderTemp             | Tmin                          | TminHold                         | Die temperature is under limit                           |
| 20    | Not Used              | N/A                           | N/A                              | Not used                                                 |
| 19    | ExtOvTemp1            | XMax1                         | –                                | External temperature 1 is over limit                     |
| 18    | ExtOvTemp2            | XMax2                         | –                                | External temperature 2 is over limit                     |
| 17-12 | Not Used              | N/A                           | N/A                              | Not used                                                 |
| 11    | Vsag                  | Vsag                          | VsagHold                         | Voltage sagged below limit                               |
| 10    | Vsurge                | Vsurge                        | VsagHold                         | Voltage surged above limit                               |
| 9     | VdropOut              | Vdrop                         | –                                | Voltage dropped below limit                              |
| 8     | OverVolt              | Vmax                          | VminHold                         | RMS voltage went above upper limit                       |
| 7     | UnderVolt             | Vmin                          | VminHold                         | RMS voltage fell below lower limit                       |
| 6     | OverCurrent           | Imax                          | ImaxHold                         | RMS current went above limit                             |
| 5     | OverPower             | Pmax                          | PmaxHold                         | Power went above limit                                   |
| 4     | OverFreq              | Fmax                          | Fminhold                         | Line frequency went above upper limit                    |
| 3     | UnderFreq             | Fmin                          | Fminhold                         | Line frequency fell below lower limit                    |
| 2     | Relay_On              | –                             | –                                | Relay is ON                                              |
| 1     | Zero_Cross            | –                             | –                                | Voltage low-to-high zero-crossing detected (auto-clears) |
| 0     | Not Used              | –                             | –                                | Not used                                                 |

Note:

- 1) These are input registers and their value can be saved in flash memory as defaults through the [ACC Command](#).

### 3.7.2 AlarmSticky Register (address 0x54)

The AlarmSticky register is an input register that allows configuring individual bits into the Alarms register to hold the alarm status (“sticky”) until an AlarmReset command is issued. Each alarm can otherwise be set to auto-reset at the completion of each accumulation interval.

The AlarmSticky register can be saved into flash memory.

**Table 3-9: AlarmSticky Register Bits Assignment**

| Bit   | Alarm       | Function                                                                                                             |
|-------|-------------|----------------------------------------------------------------------------------------------------------------------|
| 23    | N/A         | N/A                                                                                                                  |
| 22    | OverTemp    | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 21    | UnderTemp   | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 19    | ExtOvTemp1  | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 18    | ExtOvTemp2  | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 17-12 | Not Used    | Not used                                                                                                             |
| 11    | Vsag        | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 10    | Vsurge      | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 9     | VdropOut    | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 8     | OverVolt    | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 7     | UnderVolt   | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 6     | OverCurrent | 1 = Alarm bit is set until AlarmReset command is issued.<br>0 = Alarm bit is cleared at every accumulation Interval. |
| 5     | OverPower   | 1 = Alarm bit is set until AlarmReset command.<br>0 = Alarm cleared at every accumulation Interval.                  |
| 4     | OverFreq    | 1 = Alarm bit is set until AlarmReset command.<br>0 = Alarm cleared at every accumulation Interval.                  |
| 3     | UnderFreq   | 1 = Alarm bit is set until AlarmReset command.<br>0 = Alarm cleared at every accumulation Interval.                  |
| 2     | N/A         | N/A                                                                                                                  |
| 1     | N/A         | N/A                                                                                                                  |
| 0     | Not Used    | Not used                                                                                                             |

### 3.7.3 AlarmMask1 (address 0x09) and AlarmMask2 (address 0x51)

The registers AlarmMask1 and AlarmMask2 allow the user to select which alarm will be used to drive the corresponding alarm pins: AlarmMask1 controls  $\overline{\text{ACFAULT}}$  pin while AlarmMask2 controls  $\overline{\text{ACCRIT}}$  pin. For example, to select OverCurrent and Vsurge to drive the  $\overline{\text{ACFAULT}}$  pin, AlarmMask1 should be set to 0x000440. The AlarmMask1 and AlarmMask2 registers can be saved into flash memory.

**Table 3-10: AlarmMask1 and AlarmMask2 Registers Bits Assignment**

| Bit   | Alarm/<br>Status | Default | Function                                                                        |
|-------|------------------|---------|---------------------------------------------------------------------------------|
| 23    | DataReady        | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 22    | OverTemp         | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 21    | UnderTemp        | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 19    | ExtOvTemp1       | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 18    | ExtOvTemp2       | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 17-12 | Not Used         |         | Not used                                                                        |
| 11    | Vsag             | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 10    | Vsurge           | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 9     | VdropOut         | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 8     | OverVolt         | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 7     | UnderVolt        | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 6     | OverCurrent      | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 5     | OverPower        | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 4     | OverFreq         | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 3     | UnderFreq        | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 2     | Relay_On         | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 1     | Zero_Cross       | 0       | 1 = Alarm drives alarm output pin; 0 = Alarm has no effect on alarm output pin. |
| 0     | Not Used         |         | Not used                                                                        |

### 3.7.4 AlarmSet Register (address 0x0C)

The AlarmSet register is used to force an alarm by setting the corresponding bit. This register is mainly used for relay control and system test purposes.

**Table 3-11: AlarmSet Register Bit Assignments**

| Bit   | Alarm/<br>Status | Default | Function                          |
|-------|------------------|---------|-----------------------------------|
| 23    | DataReady        | 0       | 1 = Force Alarm; 0 = No Operation |
| 22    | OverTemp         | 0       | 1 = Force Alarm; 0 = No Operation |
| 21    | UnderTemp        | 0       | 1 = Force Alarm; 0 = No Operation |
| 19    | ExtOvTemp1       | 0       | 1 = Force Alarm; 0 = No Operation |
| 18    | ExtOvTemp2       | 0       | 1 = Force Alarm; 0 = No Operation |
| 17-12 | Not Used         | –       | Not used                          |
| 11    | Vsag             | 0       | 1 = Force Alarm; 0 = No Operation |
| 10    | Vsurge           | 0       | 1 = Force Alarm; 0 = No Operation |
| 9     | VdropOut         | 0       | 1 = Force Alarm; 0 = No Operation |
| 8     | OverVolt         | 0       | 1 = Force Alarm; 0 = No Operation |
| 7     | UnderVolt        | 0       | 1 = Force Alarm; 0 = No Operation |
| 6     | OverCurrent      | 0       | 1 = Force Alarm; 0 = No Operation |
| 5     | OverPower        | 0       | 1 = Force Alarm; 0 = No Operation |
| 4     | OverFreq         | 0       | 1 = Force Alarm; 0 = No Operation |
| 3     | UnderFreq        | 0       | 1 = Force Alarm; 0 = No Operation |
| 2     | Relay_On         | 0       | 1 = Force Alarm; 0 = No Operation |
| 1     | Zero_Cross       | 0       | 1 = Force Alarm; 0 = No Operation |
| 0     | Not Used         | –       | Not used                          |

### 3.7.5 AlarmReset Register (address 0x0F)

The AlarmReset register is used to clear an alarm by setting the corresponding bit.

**Table 3-12: AlarmReset Registers Bit Assignments**

| Bit   | Alarm/<br>Status | Default | Function                           |
|-------|------------------|---------|------------------------------------|
| 23    | DataReady        | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 22    | OverTemp         | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 21    | UnderTemp        | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 19    | ExtOvTemp1       | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 18    | ExtOvTemp2       | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 17-12 | Not Used         | –       | Not used                           |
| 11    | Vsag             | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 10    | Vsurge           | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 9     | VdropOut         | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 8     | OverVolt         | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 7     | UnderVolt        | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 6     | OverCurrent      | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 5     | OverPower        | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 4     | OverFreq         | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 3     | UnderFreq        | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 2     | Relay_On         | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 1     | Zero_Cross       | 0       | 1 = Clear Alarm ; 0 = No Operation |
| 0     | Not Used         | –       | Not used                           |

**3.7.6 Alarms Configuration Registers (Thresholds and Hold-Off Time)****Table 3-13: Alarms Threshold Registers**

| Address | Register   | Format | Flash Saved | Default   | Description                                                                                     |
|---------|------------|--------|-------------|-----------|-------------------------------------------------------------------------------------------------|
| 0x69    | VsurgeTh   | UINT24 | Y           | 225,000   | Voltage threshold above which VSURGE alarm is activated.                                        |
| 0x6C    | VsagTh     | UINT24 | Y           | 95,000    | Voltage threshold below which VSAG alarm will be activated.                                     |
| 0x6F    | VminTh     | UINT24 | Y           | 95,000    | Voltage threshold below which UNDERVOLT alarm will be activated.                                |
| 0x72    | VmaxTh     | UINT24 | Y           | 245,000   | Voltage threshold above which OVERVOLT alarm will be activated.                                 |
| 0x75    | VdropTh    | UINT24 | Y           | 95,000    | Voltage threshold below which VDROP alarm will be activated.                                    |
| 0x78    | ImaxTh     | UINT24 | Y           | 30,000    | Current High Alarm Limit                                                                        |
| 0x7B    | PmaxTh     | UINT24 | Y           | 7,350,000 | Power High Alarm Limit                                                                          |
| 0x7E    | TminTh     | INT24  | Y           | -40,000   | Die temperature threshold below which the UNDERTEMP alarm will be activated.                    |
| 0x81    | TmaxTh     | INT24  | Y           | 125,000   | Die temperature threshold above which the OVERTEMP alarm will be activated.                     |
| 0x84    | Temp1Thres | UINT24 | Y           | 0         | External temperature (thermistor) threshold below which the ExtOvTemp1alarm will be activated.  |
| 0x87    | Temp2Thres | UINT24 | Y           | 0         | External temperature (thermistor) threshold below which the ExtOvTemp2 alarm will be activated. |
| 0x8A    | FminTh     | UINT24 | Y           | 40,000    | Line Frequency threshold below which the UNDERFREQ alarm will be activated.                     |
| 0x8D    | FmaxTh     | UINT24 | Y           | 70,000    | Line frequency threshold above which the OVERFREQ alarm will be activated.                      |

**Table 3-14: Alarms Hold-Off Timers Registers**

| Address | Register           | Format | Flash Saved | Default | Description                                                                                                                                                         |
|---------|--------------------|--------|-------------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x90    | VSagHo<br>VSurgeHo | UINT24 | Y           | 4       | Hold-off Time (in High-rate sample) for Voltage Sag and Surge Alarm (shared)                                                                                        |
| 0x93    | Not Used           | —      | —           | —       |                                                                                                                                                                     |
| 0x96    | VminHo<br>VmaxHo   | UINT24 | Y           | 4       | Number of consecutive accumulation intervals in which the RMS voltage must exceed the specified limit before the UNDERVOLT or OVERVOLT alarms will be activated.    |
| 0x99    | ImaxHo             | UINT24 | Y           | 4       | Number of consecutive accumulation intervals in which the RMS current must exceed the IMAX threshold before the OVERCURRENT alarm will be activated.                |
| 0x9C    | PmaxHo             | INT24  | Y           | 4       | Number of consecutive accumulation intervals in which power must exceed the PMAX threshold before the OVERWATT alarm will be activated.                             |
| 0x9F    | TminHo<br>TmaxHo   | INT24  | Y           | 4       | Number of consecutive accumulation intervals in which the die temperature must exceed either TMIN or TMAX before the OVERTEMP or UNDERTEMP alarm will be activated. |
| 0xA2    | FminHo<br>FmaxHo   | UINT24 | Y           | 4       | Number of consecutive accumulation intervals in which the line frequency must exceed either FMIN or FMAX before the UNDERFREQ or OVERFREQ alarm will be activated.  |

### 3.7.7 Alarm Counter Registers

Counter registers increment at each alarm occurrence and can be cleared by the user by writing a zero value.

**Table 3-15: Alarms Counter Registers**

| Address | Register  | Format | Description                                                 |
|---------|-----------|--------|-------------------------------------------------------------|
| 0xAE    | TminCnt   | UINT24 | The number of times an UNDERTEMP event has been detected.   |
| 0xB1    | TmaxCnt   | UINT24 | The number of times an OVERTEMP event has been detected.    |
| 0xB4    | VminCnt   | UINT24 | The number of times an UNDERVOLT event has been detected.   |
| 0xB7    | VmaxCnt   | UINT24 | The number of times an OVERVOLT event has been detected.    |
| 0xBA    | ImaxCnt   | UINT24 | The number of times an OVERCURRENT event has been detected. |
| 0xBD    | PmaxCnt   | UINT24 | The number of times an OVERWATT event has been detected.    |
| 0xC0    | FminCnt   | UINT24 | The number of times an UNDERFREQ event has been detected.   |
| 0xC3    | FmaxCnt   | UINT24 | The number of times an OVERFREQ event has been detected.    |
| 0xC6    | VsagCnt   | UINT24 | The number of times a VSAG event has been detected.         |
| 0xC9    | Vsurgecnt | UINT24 | The number of times a VSURGE event has been detected.       |

### 3.8 Command Register

This register is used to issue commands to perform specific tasks to the device. Use of any command not listed in this document can cause unpredictable and possibly dangerous behavior.

#### 3.8.1 General Settings

The General Settings command allows the user to enable functions such as UART auto reporting, relay operations, and Line Lock mode, etc. These settings are used with all other commands and are stored as nonvolatile settings upon use of the Save to Flash Command (0xACC2xx).

**Table 3-16: General Settings Command Bits**

| Bit(s) | Value | Description                                                                                                                                                                                                                                                                                                                            |
|--------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7      | 0     | Not used                                                                                                                                                                                                                                                                                                                               |
| 6      | FREQ  | Stop Frequency Update: 1=stop; 0=update.<br>This bit stops the update of Freq used by the sine/cosine generator for fundamental and harmonic measurements. It is the unscaled value of Frequency with 8 integer and 16 fraction bits. The user can set the fundamental frequency when FREQ is set.                                     |
| 5      | LL    | Line Lock: 1= lock to line cycle; 0= independent.<br>This bit selects the accumulation interval (computation cycle) mode. If not locked the computation is executed over a fixed number of samples (high rate) contained in the Accum register. If locked, the computation is executed over a number of samples accumulation interval. |
| 4      | TC    | Enable Gain/Temperature Compensation: 1=enable; 0=disable.<br>This bit allows the firmware to modify the system gain based on measured temperature.                                                                                                                                                                                    |
| 3      | AR    | Enable Auto Reporting: 1=enable; 0=disable.<br>This bit enables auto reporting mode on UART. The user or host can also set or clear this command bit, enabling or disabling auto reporting.                                                                                                                                            |
| 2      | AY    | Enable Autonomous Relay Operation: 1=enable; 0=disable/normal mode.<br>This bit enables autonomous relay operation. The user or host can also set or clear this command bit, enabling or disabling autonomous operation.                                                                                                               |
| 1:0    | 0     | Not used                                                                                                                                                                                                                                                                                                                               |

#### 3.8.2 No Action (0x00xxxx)

The No Action command allows the user to disable temperature updates.

**Table 3-17. No Action Command Bits**

| Bit(s) | Value | Description                                                                                                                                                                                                  |
|--------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23:12  | 0x00  | No action                                                                                                                                                                                                    |
| 11     | 0     | Not used                                                                                                                                                                                                     |
| 10     | T     | Stop Temperature Update: 1=stop; 0=update.<br>This bit prevents the firmware from overwriting the TempC (temperature result) register. This is necessary when supplying a known temperature for calibration. |
| 9:8    | 0     | Not used                                                                                                                                                                                                     |
| 7:0    |       | See General Settings                                                                                                                                                                                         |

### 3.8.3 Save to Flash Command (0xACC2xx)

Use this command to save to flash the calibration coefficients and system defaults contained in the some of the input registers. Upon reset or power-on, the values stored in flash will become new system defaults. The General Settings bits ([7:0]) are stored in nonvolatile storage while the upper 16 bits (23:16)) are stored as 0x0000 (No Action Command). When the process completes, bits [23:8] are cleared. The following table describes the command bits.

**Table 3-18. Save to Flash Command Bits**

| Bit(s) | Value | Description                      |
|--------|-------|----------------------------------|
| 23:12  | 0xACC | “Access” Command                 |
| 11:8   | 0x2   | Save nonvolatile values to flash |
| 7:0    | —     | See General Settings (0x00xxxx)  |

### 3.8.4 Clear Flash Storage 0 Command (0xACC0xx)

Use this command to clear the flash coefficients (nonvolatile system defaults for some of the input registers). Upon reset or power-on, the values revert to factory system defaults. This command should always be used in conjunction with Clear Flash Storage 1 Command (0xACC1xx). When the process completes, bits [23:8] are cleared.

**Table 3-19. Clear Flash Storage 0 Command Bits**

| Bit(s) | Value | Description                       |
|--------|-------|-----------------------------------|
| 23:12  | 0xACC | “Access” Command                  |
| 11:8   | 0x0   | Clear nonvolatile values in flash |
| 7:0    | —     | See General Settings (0x00xxxx)   |

### 3.8.5 Clear Flash Storage 1 Command (0xACC1xx)

Use this command to clear the flash coefficients (nonvolatile system defaults for some of the input registers). Upon reset or power-on, the values revert to factory system defaults. This command should always be used in conjunction with Clear Flash Storage 0 Command (0xACC0xx). When the process completes, bits [23:8] are cleared.

**Table 3-20. Clear Flash Storage 1 Command Bits**

| Bit(s) | Value | Description                       |
|--------|-------|-----------------------------------|
| 23:12  | 0xACC | “Access” Command                  |
| 11:8   | 0x1   | Clear nonvolatile values in flash |
| 7:0    | —     | See General Settings (0x00xxxx)   |

### 3.8.6 Calibration Command (0xCAxxxx)

Use this command to start the calibration process for the selected inputs. It is assumed that appropriate input signals are applied before starting calibration. When the calibration process completes, bits [23:16] are cleared along with bits associated with channels that calibrated successfully. Any channels that failed will have their corresponding bit left set.

**Table 3-21. Calibration Command Bits**

| Bit(s) | Value | Description                                                   |
|--------|-------|---------------------------------------------------------------|
| 23:16  | 0xCA  | “Calibrate” Command                                           |
| 15:14  | 0     | Not used (set to 0)                                           |
| 13     | XYR   | Calibrate X+Y or R Compensation Coefficient (instead of gain) |
| 12     | V     | Calibrate Voltage (gain or offset)                            |
| 11     | I     | Calibrate Current (gain or offset)                            |
| 10     | T     | Calibrate Chip Temperature                                    |
| 9      | O     | Calibrate Offset (instead of gain) for Current or Voltage     |
| 8      | XT    | Calibrate External Temperature Gain                           |
| 7:0    | —     | See General Settings (0x00xxxx)                               |

## 4 Serial Interfaces

All user registers are contained in a 256 word (24-bits each) area of the on-chip RAM and can be accessed through the UART, SPI, or I<sup>2</sup>C interfaces. For word-addressable SPI and I<sup>2</sup>C interfaces, one must divide the documented register address by 3. While access to a single byte is possible with some interfaces, it is highly recommended that the user access words (or multiple words) of data with each transaction.

### Serial Interface Selection

The 78M6610+PSU provides UART, I<sup>2</sup>C, and SPI interface options, but only one interface can be active at a time. The user activates the interface through the configuration of pins IFCONFIG and SSB/DIR/SCL according to the following table.

| Selected Interface | SSB/DIR/SCL    | IFCONFIG |
|--------------------|----------------|----------|
| SPI                | X (don't care) | 0        |
| UART               | 0              | 1        |
| I <sup>2</sup> C   | 1              | 1        |

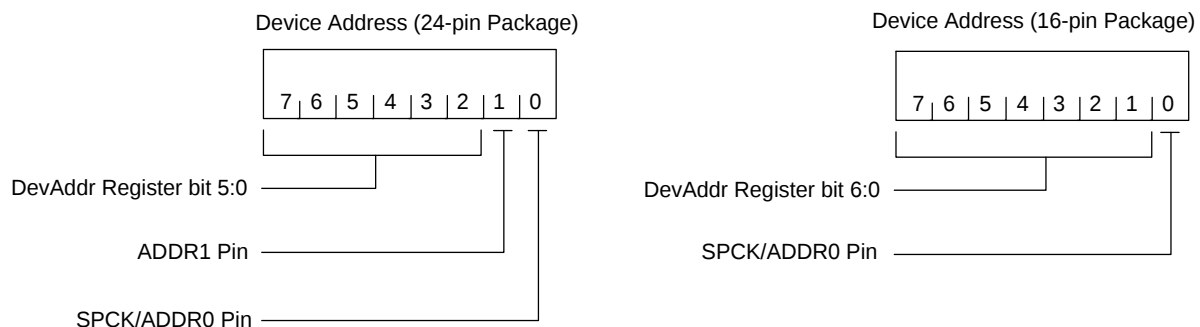
The interface selection pins are sampled following power-on and reset. The user should allow at least 10ms from a power-on or reset event for them to be latched and the serial interface selected. During this time the status of these pins must not change.

#### Warning

Where applicable, pins should be configured via pull-up and pull-down resistors as these pins could become outputs after initialization. Therefore, direct connection to GNDD/GNDA or V<sub>3P3D</sub>/V<sub>3P3A</sub> supplies must be avoided.

### Device Address (UART)

The UART interface supports a multi-point communications protocol. Each device is identified by a specific address that is configured through the DevAddr register and pins Addr0 and Addr1 according to the following figure. DevAddr Register Bits 23 through 7 are not used and should be set to 0. Their status has no effect on the device address.



A change of the address is always effective after a power-on or reset. During the initialization following a power-on or reset, the DevAddr register value is restored with the value contained in Flash memory and the address pin status is acquired.

It is possible to modify the device address by setting the DevAddr register (through any of the interfaces) as well as the address pins status. If DevAddr register is modified, it is necessary to save its content into Flash through the ACC command. Following a reset or power-on the device will resume operation with the new address.

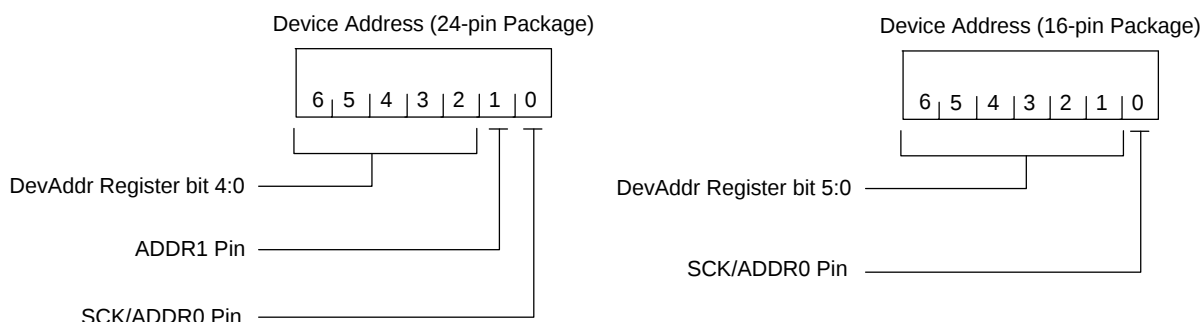
**Note**

**In UART operation, the implemented protocol does not directly use the device address. An SSI ID equal to the device address+1 is used. For example, the theoretical device address range of 0 to 127 corresponds to an SSI ID range of 1 to 128.**

**Device Address (I<sup>2</sup>C)**

The I<sup>2</sup>C interface address can be set through device pins and the DevAddr register.

The upper 5 bits (on 24-pin device) or 6 bits (on 16-pin device) are set through the DevAddr register. While the lower 2-bits (24-pin device) or 1-bit (16-pin device) are set through the ADDR1 and ADDR0 pins, according to the following figure.



The DevAddr register bits 23 through 6 are not used and their status has no effect on the device address configuration.

A change of the address is always effective after a power-on or reset. During the initialization following a power-on or reset, the DevAddr register value is restored with the value contained in Flash memory and the address pin status is acquired.

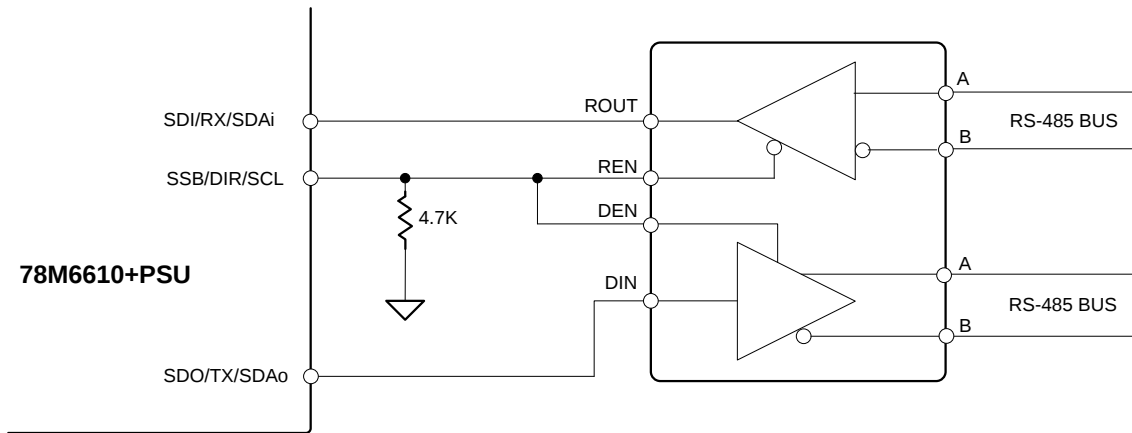
It is possible to modify the device address by setting the DevAddr register (through any of the interfaces) as well as the address pins status. If DevAddr register is modified, it is necessary to save its content into Flash through the ACC command. Following a reset or power-on the device will resume operation with the new address.

## 4.1 UART Interface

The byte-addressable UART interface on the 78M6610+PSU features a binary communication protocol called SSI with two modes:

- A Command Response mode supporting single and multi-point communications, including direction control for an RS-485 transceiver. This mode supports a 4-wire RS-485 bus.
- An Auto Report mode that transmits data automatically at the completion of an accumulation interval without host intervention.

The supported configuration is 38400 baud, 8-bit, no-parity, 1 stop-bit, no flow control. The SSB/DIR/SCL pin is used to drive an RS-485 transceiver output enable or direction pin.



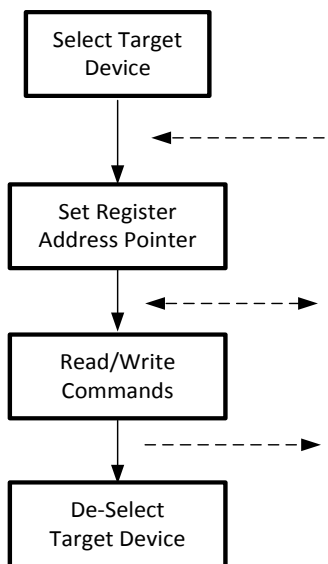
**Figure 4-1: UART Connections on a RS-485 Bus**

The implemented SSI protocol uses binary packets, which contain synchronization, addressing, payload, and data integrity check. The responses also contain acknowledge/error indicators.

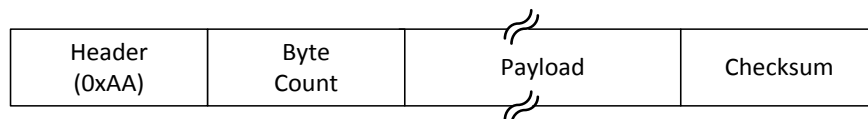
The SSI ID for each 78M6610+PSU is defined by a device address that is configured through the register DevAddr, which provides address bits 7 through 2 of the device address. While address bits 0 and 1 are configured through pins ADDR1 and SCK/ADDR0 (24-pin package). In 16-pin package devices, the DevAddr register provides address bits 7 through 1, while bit 0 is configured through the pin SCK/ADDR0.

#### 4.1.1 Command-Response Protocol Description

In this protocol, the host is the master and must initiate communications. The master should first select the device that needs to communicate with, then set the device's register address pointer and finally performing the read or write operations. The sequence of operation is shown in the following diagram.



After sending the synchronization header code (0xAA), the master sends (in the following order) the byte counts (size of whole packet), the payload and then the checksum that provides data integrity check. The following figure shows a generic command packet generated from the master:



The payload contains commands, device address, registers address, data etc. The payload can contain either a single command or multiple commands. The protocol allows for reading or writing one up to 252 bytes in a single operation. Following is the data access method for both read and write. Only the payload is shown.

##### Device Selection

The device needs to be selected first using the following command:

| PAYLOAD         |        |
|-----------------|--------|
| 0xCF<br>Command | SSI ID |

The 78M6610+PSU replies with an acknowledge message.

Once the device is selected, the SSB/DIR/SCL pin will be asserted (logic high), enabling the RS-485 bus driver. The SSB/DIR/SCL pin will be asserted until the device is de-selected.

### Register Address Pointer Selection

The following message sets the address pointer to the register (or set of registers) to read or write:

| PAYLOAD         |                               |
|-----------------|-------------------------------|
| 0xA3<br>Command | Register Address<br>(2 Bytes) |

The 78M6610+PSU replies with an acknowledge message.

### Read Command

It is possible to read data from the 78M6610+PSU using the 0xE command. To read 0 to 15 bytes, the command byte is completed with the number of bytes to read. For example, to read 3 bytes:

| PAYLOAD         |  |
|-----------------|--|
| 0xE3<br>Command |  |

In order to read a larger number of bytes (up to 255), the command 0xE0 must be used. In this case, the command 0xE0 must be followed by a byte containing the number of bytes to be read. For example to read 31 bytes:

| PAYLOAD         |                                   |
|-----------------|-----------------------------------|
| 0xE0<br>Command | 0x1F<br>(Number of Bytes to Read) |

### Write Command

It is possible to write data to the 78M6610+PSU using the 0xD command. To write 1 to 15 bytes, the command byte must be completed with the number of bytes of data to write. For example to write 3 bytes:

| PAYLOAD         |                               |
|-----------------|-------------------------------|
| 0xD3<br>Command | Data<br>(Number of Bytes = 3) |

In order to write a larger number of bytes (up to 255), the command 0xD0 must be used. In this case, the number of data bytes to follow is determined by the Byte Count. For example to write 31 bytes:

| PAYLOAD         |                                            |
|-----------------|--------------------------------------------|
| 0xD0<br>Command | Data<br>(Number of Bytes = Byte Count – 4) |

After each read or write operation, the internal address pointer is incremented to point to the address that followed the target of the previous read or write operation.

[Table 4-1](#) lists the commands that are supported by the 78M6610+PSU.

**Table 4-1: Host Commands**

| Command | Parameters       | Description                                |
|---------|------------------|--------------------------------------------|
| 0 - 7F  |                  | (invalid)                                  |
| 80 - 9F |                  | (not used)                                 |
| A0      |                  | Clear address                              |
| A1      | [byte-L]         | Set Read/Write address bits [7:0]          |
| A2      | [byte-H]         | Set Read/Write address bits [15:8]         |
| A3      | [byte-L][byte-H] | Set Read/Write address bits [15:0]         |
| A4 - AF |                  | (reserved for larger address targets)      |
| B0 - BF |                  | (not used)                                 |
| C0      |                  | De-select Target (target will Acknowledge) |
| C1 - CE |                  | Select target 1 to 14                      |
| CF      | [byte]           | Select target 0 to 255                     |
| D0      | [data...]        | Write bytes set by remainder of Byte Count |
| D1 - DF | [data...]        | Write 1 to 15 bytes                        |
| E0      | [byte]           | Read 0 to 255 bytes                        |
| E1 – EF |                  | Read 1 to 15 bytes                         |
| F0 - FF |                  | (not used)                                 |

### Slave Packets

The 78M6610+PSU replies to the host processor either with an acknowledge (either ACK or NACK) or with data. The format of slave packets depends upon the type of response to the master device.

[Table 4-2](#) lists the reply codes and their meanings.

**Table 4-2: Slave Reply Codes**

| Code        | Definition                                          |
|-------------|-----------------------------------------------------|
| 0xAA        | Acknowledge with data.                              |
| 0xAE        | Auto Reporting Header (with data).                  |
|             |                                                     |
| 0xAD        | Acknowledge without data.                           |
| 0xB0        | Negative Acknowledge (NACK).                        |
|             |                                                     |
| 0xBC        | Command not implemented.                            |
| 0xBD        | Checksum failed.                                    |
|             |                                                     |
| 0xBF        | Buffer overflow (or packet too long).               |
| - timeout - | Any condition too difficult to handle with a reply. |

#### 4.1.2 Auto-Reported Data

By default, the 78M6610+PSU automatically reports a set of data at the completion of each accumulation interval. This mode is used in systems where the host will not have to poll the 78M6610+PSU for data but it receives automatically data updated at the accumulation interval rate. [Table 4-3](#) shows the default auto-reported data format.

**Table 4-3: Default Measurements**

| Parameter/Register | Number of Bytes | Description                                          |
|--------------------|-----------------|------------------------------------------------------|
| Packet Header      | 1               | Start of Data Packet                                 |
| Packet Length      | 1               | Number of Bytes in the Packet                        |
| Vrms               | 3               | RMS Voltage (address 0x1B)                           |
| Irms               | 3               | RMS Current (address 0x1E)                           |
| Watt               | 3               | Active Power (address 0x21)                          |
| PAverage           | 3               | Active Power (30s average) (address 0x24)            |
| PF                 | 3               | Power Factor (address 0x27)                          |
| Frequency          | 3               | Line Frequency (address 0x2A)                        |
| DevAddr            | 3               | High Order Device ID and Address Bits (address 0x2D) |
| Alarms             | 3               | Alarms and Status (address 0x30)                     |

The content of the auto-reported data packet is configurable by the user. Refer to the relevant application note describing the auto-report packet configuration procedure.

## 4.2 SPI Interface

The Maxim device operates as a SPI slave. The host is expected to instigate and control all transactions. The signals used for SPI communication are defined as:

- **SSB** : (also known as **CSB**) the device SPI chip/slave select signal (active low)
- **SCK** : the clocking signal that clocks **MISO** and **MOSI** (data)
- **SDI** : (also known as **MOSI**) the data shifted into the measurement device
- **SDO** : (also known as **MISO**) the data shifted out of the measurement device

In Maxim embedded measurement devices, these signals may have alternate functionality depending upon the device mode and/or firmware.

### SPI Mode

The device operates as a slave in mode 3 (CPOL=1,CPHA==1) and as such the data is captured on the rising edge and propagated on the falling edge of the serial data clock(SCK). Figure 1 shows a single-byte transaction on the SPI bus. Bytes are transmitted/received MSB first.

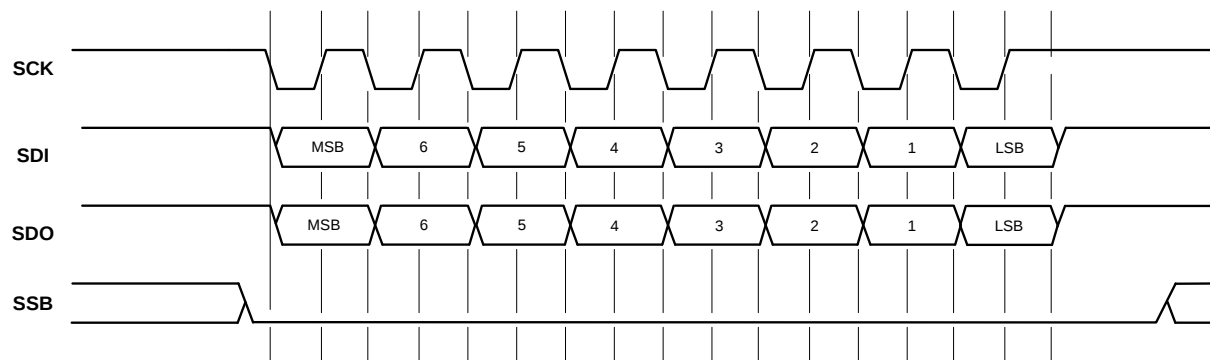


Figure 4-2: Signal Timing on the SPI Bus

### Single Word SPI Reads

The device supplies direct read access to the device RAM memory. To read the RAM the master device must send a read command to the slave device and then clock out the resulting read data. SSB must be kept active low for the entire read transaction (command and response). SCK may be interrupted as long as SSB remains low. ADDR[5:0] is filled with the word address of the read transaction. RAM data contents are transmitted most significant byte first. ADDR[5:0] cannot exceed 0x3F. RAM words, and therefore the results, are natively 24 bits (3 bytes) long.

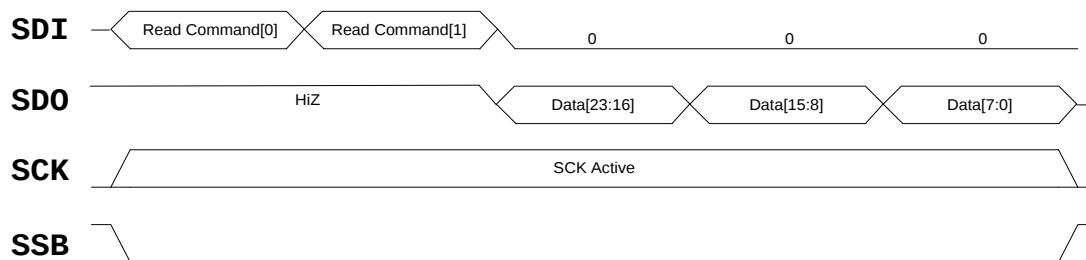
| Byte# | Bit 7     | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|-----------|-------|-------|-------|-------|-------|-------|-------|
| 0     | 0x01      |       |       |       |       |       |       |       |
| 1     | ADDR[5:0] |       |       |       |       |       | 0x0   |       |
| 2     | 0         |       |       |       |       |       |       |       |
| 3     | 0         |       |       |       |       |       |       |       |
| 4     | 0         |       |       |       |       |       |       |       |

**Table 4-4. Single Word SPI Read Command (SDI)**

The slave responds with the data contents of the requested RAM addresses.

| Byte Number | Bit 7                      | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------------|----------------------------|-------|-------|-------|-------|-------|-------|-------|
| 0           | Hi-Z (during Read Command) |       |       |       |       |       |       |       |
| 1           | Hi-Z (during Read Command) |       |       |       |       |       |       |       |
| 2           | DATA[23:16] @ ADDR         |       |       |       |       |       |       |       |
| 3           | DATA[15:8] @ ADDR          |       |       |       |       |       |       |       |
| 4           | DATA[7:0] @ ADDR           |       |       |       |       |       |       |       |

**Table 4-5. Single Word SPI Read Response (SDO)**



**Figure 4-3: Single Word Read Access Timing**

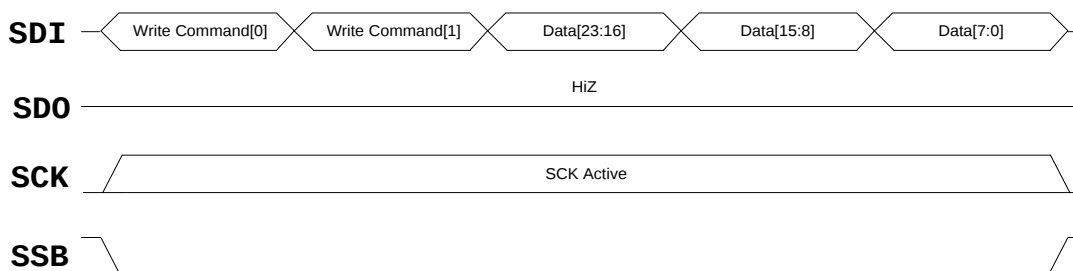
### Single Word SPI Writes

The device supplies direct write access to the device RAM memory. To write the RAM the master device must send a write command to the slave device and then clock out the write data. SSB must be kept active low for the entire write transaction (command and data). SCK may be interrupted as long as SSB remains low. ADDR[5:0] is filled with the word address of the write transaction. RAM data contents are transmitted most significant byte first. ADDR[5:0] cannot exceed 0x3F. RAM words are natively 24 bits (3 bytes) long.

| Byte# | Bit 7              | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|--------------------|-------|-------|-------|-------|-------|-------|-------|
| 0     | 0x01               |       |       |       |       |       |       |       |
| 1     | ADDR[5:0]          |       |       |       |       |       | 0x02  |       |
| 2     | DATA[23:16] @ ADDR |       |       |       |       |       |       |       |
| 3     | DATA[15:8] @ ADDR  |       |       |       |       |       |       |       |
| 4     | DATA[7:0] @ ADDR   |       |       |       |       |       |       |       |

**Table 4-6. Single Word SPI Write Command and Data (SDI)**

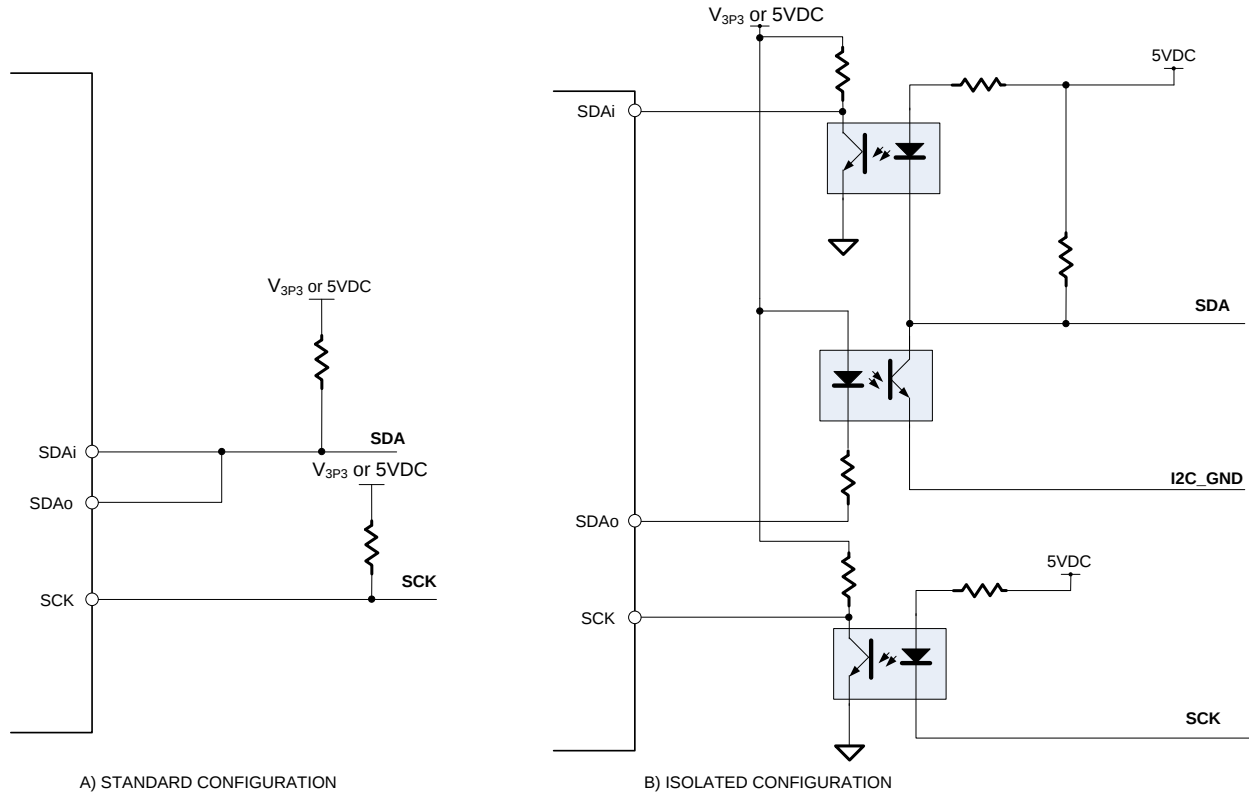
The slave SDO remains Hi-Z during a write access.



**Figure 4-4: Single Word Write Access Timing**

### 4.3 I<sup>2</sup>C Interface

The 78M6610+PSU has an I<sup>2</sup>C interface available at the SDAI, SDAO, and SCK pins. The interface supports I<sup>2</sup>C slave mode with a 7-bit address and operates at a data rate up to 400kHz. [Figure 4-5](#) shows two possible configurations. Configuration A is the standard configuration. The double pin for SDA allows the isolated configuration B.



**Figure 4-5: I<sup>2</sup>C Bus Connection in Standard (A) and Isolated (B) Configuration**

The I<sup>2</sup>C interface allows access to read and write registers contained in a 256 word (24-bit) area of the on-chip RAM. The address of each register specified in [Section 3](#) must be divided by 3 to obtain the relevant address for the I<sup>2</sup>C access. While access to a single byte is possible, it is highly recommended that the user access words (or multiple words) of data with each transaction.

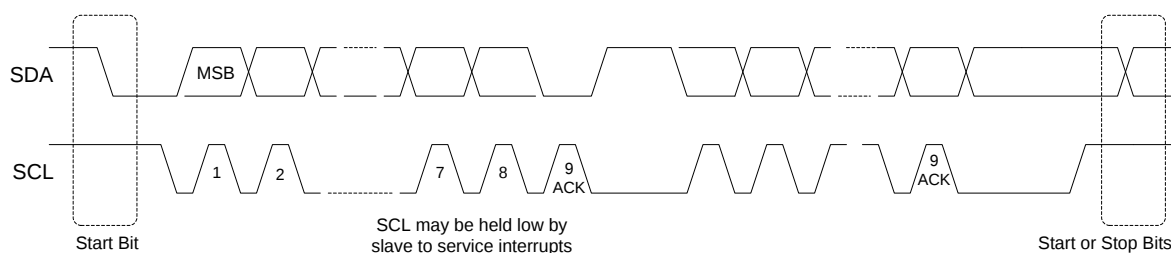
The device address of each 78M6610+PSU is configured through the register DevAddr, which defines address bits 6 through 2 of the device address. Address bits 0 and 1 are configured through pins ADDR1 and SCK/ADDR0 (24-pin package). With the 16-pin package option, the DevAddr register defines address bits 6 through 1, while bit 0 is configured through the pin SCK/ADDR0.

## Bus Characteristics

- A data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH will be interpreted as a START or STOP condition.

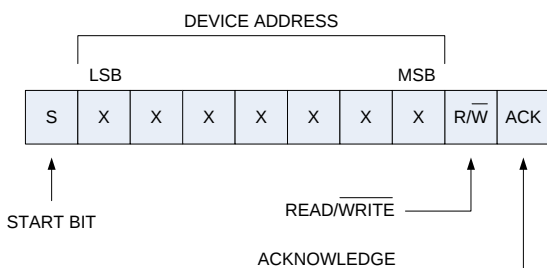
### Bus Conditions:

- **Bus not Busy (I):** Both data and clock lines are HIGH indicating an Idle Condition.
- **Start Data Transfer (S):** a HIGH to LOW transition of the SDA line while the clock (SCL) is HIGH determines a START condition. All commands must be preceded by a START condition.
- **Stop Data Transfer (P):** a LOW to HIGH transition of the SDA line while the clock (SCL) is HIGH determines a STOP condition. All operations must be ended with a STOP condition.
- **Data Valid:** The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal. The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data. Each data transfer is initiated with a START condition and terminated with a STOP condition.
- **Acknowledge (A):** Each receiving device, when addressed, is obliged to generate an acknowledge after the reception of each byte. The master device must generate an extra clock pulse, which is associated with this Acknowledge bit. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge-related clock pulse. Of course, setup and hold times must be taken into account. During reads, a master must signal an end of data to the slave by not generating an Acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave (78M6610+PSU) will leave the data line HIGH to enable the master to generate the STOP condition.



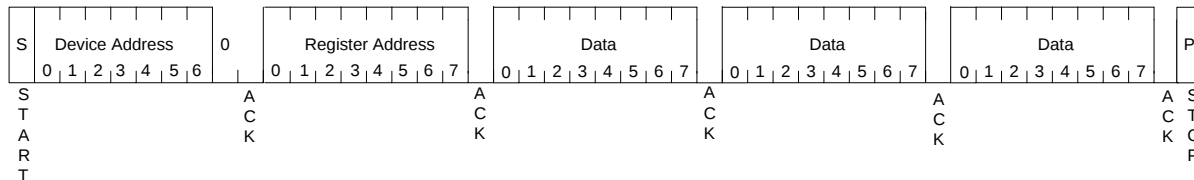
## Device Addressing

A control byte is the first byte received following the START condition from the master device. The control byte consists of a seven bit address and a bit (LSB) indicating the type of access (0=write; 1=read).



## Write Operations

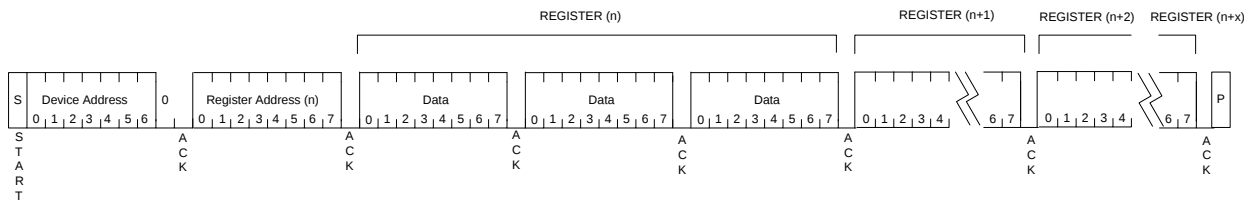
Following the START (S) condition from the master, the device address (7-bits) and the R/W bit (logic low for write) are clocked onto the bus by the master. This indicates to the addressed slave receiver that the register address will follow after it has generated an acknowledge bit (A) during the ninth clock cycle. Therefore, the next byte transmitted by the master is the register address and will be written into the address pointer of the 78M6610+PSU. After receiving another acknowledge (A) signal from the 78M6610+PSU the master device will transmit the data byte(s) to be written into the addressed memory location. The data transfer ends when the master generates a STOP (P) condition. This initiates the internal write cycle. The example in [Figure 4-6](#) shows a 3-byte data write (24-bit register write).



**Figure 4-6: I²C Bus 3-byte Data Write**

Upon receiving a STOP (P) condition, the internal register address pointer will be incremented.

The write access can be extended to multiple sequential registers. [Figure 4-7](#) shows a transaction where multiple register are written sequentially.



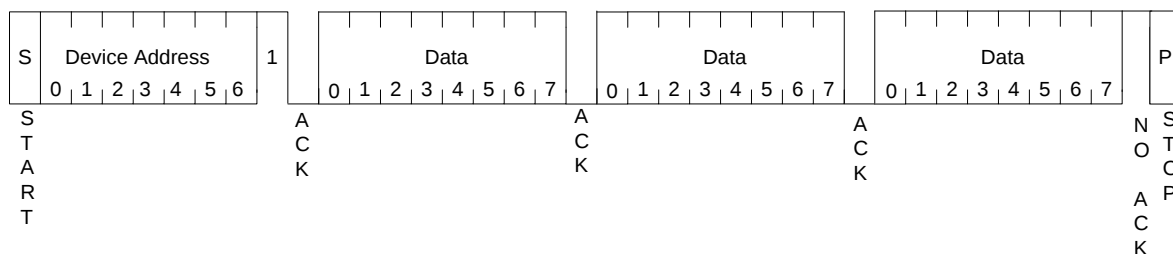
**Figure 4-7: I²C Bus Multiple Sequential Register Write**

## Read Operations

Read operations are initiated in the same way as write operations with the exception that the R/W bit of the control byte is set to one. There are two basic types of read operations: current address read and random read.

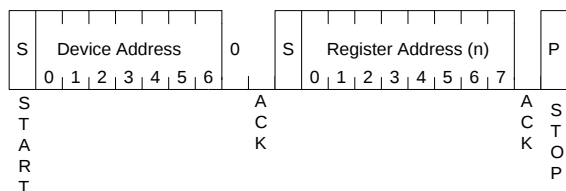
**Current Address Read:** the 78M6610+PSU contains an address counter that maintains the address of the last register accessed, internally incremented by one when the STOP bit is received. Therefore, if the previous read access was to register address  $n$ , the next current address read operation would access data from address  $n + 1$ .

Upon receipt of the control byte with R/W bit set to one, the 78M6610+PSU issues an acknowledge (A) and transmits the eight bit data byte. The master will not acknowledge the transfer, but generates a STOP condition to end the transfer and the 78M6610+PSU will discontinue the transmission.



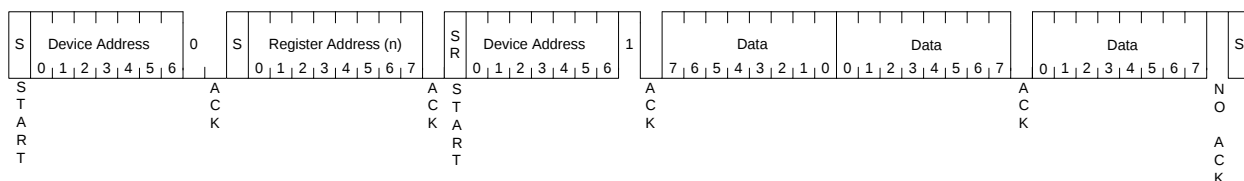
This read operation is not limited to 3 bytes but can be extended until the register address pointer reaches its maximum value.

If the register address pointer has not been set by previous operations, it is necessary to set it issuing a command as follows:



**Random Read:** random read operations allow the master to access any register in a random manner. To perform this operation, the register address must be set as part of the write operation. After the address is sent, the master generates a START condition following the acknowledge response. This sequence completes the write operation. The master should issue the control byte again this time, with the R/W bit set to 1 to indicate a read operation. The 78M6610+PSU will issue the acknowledge response, and transmit the data.

At the end of the transaction the master will not acknowledge the transfer and generate a STOP condition.



This read operation is not limited to 3 bytes but can be extended until the register address pointer reaches its maximum value.

## 5 Electrical Specifications

### 5.1 Absolute Maximum Ratings

|                                                                                                                                                     |                                                   |
|-----------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|
| <b>Supplies and Ground Pins:</b>                                                                                                                    |                                                   |
| $V_{3P3D}$ , $V_{3P3A}$                                                                                                                             | -0.5V to 4.6V                                     |
| GNDD, GNDA                                                                                                                                          | -0.5V to +0.5V                                    |
| <b>Analog Input Pins:</b>                                                                                                                           |                                                   |
| AVN, AVP, AIN, AIP, ATEMP1, ATEMP2                                                                                                                  | -10mA to +10mA<br>-0.5V to ( $V_{3P3} + 0.5V$ )   |
| <b>Oscillator Pins:</b>                                                                                                                             |                                                   |
| XIN, XOUT                                                                                                                                           | -10mA to +10mA<br>-0.5V to +3.0V                  |
| <b>Digital Pins:</b>                                                                                                                                |                                                   |
| IFCONFIG, $\overline{ACFAULT}$ , ADDR1, SSB/DIR/SCL, $\overline{ACCRIT}$ ; SDO/TX/SDAo, SDI/RX/SDAi, ADDR0, RELAYCTRL, MP0, MP1, $\overline{RESET}$ | -30mA to +30mA,<br>-0.5V to ( $V_{3P3D} + 0.5V$ ) |
| <b>Temperatures:</b>                                                                                                                                |                                                   |
| Operating Junction Temperature (peak, 100ms)                                                                                                        | +140°C                                            |
| Operating Junction Temperature (continuous)                                                                                                         | +125°C                                            |
| Storage Temperature                                                                                                                                 | -65°C to +150°C                                   |
| Soldering Temperature (10-second duration)                                                                                                          | +250°C                                            |
| ESD Stress on All Pins                                                                                                                              | ±4kV                                              |

Stresses beyond Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltages are with respect to GND.

### 5.2 Recommended External Components

| Name | From | To   | Function                                                                                                       | Value  | Unit |
|------|------|------|----------------------------------------------------------------------------------------------------------------|--------|------|
| XTAL | XIN  | XOUT | 20.000MHz                                                                                                      | 20.000 | MHz  |
| CXS  | XIN  | GND  | Load capacitor for crystal (exact value depends on crystal specifications and parasitic capacitance of board). | 18±10% | pF   |
| CXL  | XOUT | GND  |                                                                                                                | 18±10% | pF   |

### 5.3 Recommended Operating Conditions

| Parameter                         | Condition        | Min | Typ | Max | Unit |
|-----------------------------------|------------------|-----|-----|-----|------|
| 3.3V Supply Voltage ( $V_{3P3}$ ) | Normal Operation | 3.0 | 3.3 | 3.6 | V    |
| Operating Temperature             |                  | -40 | —   | +85 | °C   |

## 5.4 Performance Specifications

Note that production tests are performed at room temperature.

### 5.4.1 Input Logic Levels

| Parameter                                  | Condition | Min | Typ | Max | Unit |
|--------------------------------------------|-----------|-----|-----|-----|------|
| Digital high-level input voltage, $V_{IH}$ |           | 2   | –   | –   | V    |
| Digital low-level input voltage, $V_{IL}$  |           | –   | –   | 0.8 | V    |

### 5.4.2 Output Logic Levels

| Parameter                                  | Condition                  | Min             | Typ | Max | Unit |
|--------------------------------------------|----------------------------|-----------------|-----|-----|------|
| Digital high-level output voltage $V_{OH}$ | $I_{LOAD} = 1 \text{ mA}$  | $V_{3P3} - 0.4$ | –   | –   | V    |
|                                            | $I_{LOAD} = 10 \text{ mA}$ | $V_{3P3} - 0.6$ | –   | –   | V    |
| Digital low-level output voltage $V_{OL}$  | $I_{LOAD} = 1 \text{ mA}$  | 0               | –   | 0.4 | V    |
|                                            | $I_{LOAD} = 10 \text{ mA}$ | –               | –   | 0.5 | V    |

### 5.4.3 Supply Current

| Parameter                                      | Condition                                 | Min | Typ | Max  | Unit |
|------------------------------------------------|-------------------------------------------|-----|-----|------|------|
| $V_{3P3D}$ and $V_{3P3A}$ current (compounded) | Normal Operation, $V_{3P3} = 3.3\text{V}$ | –   | 8.1 | 10.3 | mA   |

### 5.4.4 Crystal Oscillator

| Parameter               | Condition | Min | Typ   | Max | Unit |
|-------------------------|-----------|-----|-------|-----|------|
| XIN to XOUT Capacitance |           | –   | $3^1$ | –   | pF   |
| Capacitance to GND      |           |     |       |     |      |
| XIN                     |           | –   | $5^1$ | –   | pF   |
| XOUT                    |           |     | $5^1$ |     | pF   |

<sup>1</sup> Guaranteed by design, not subject to test.

### 5.4.5 Internal RC Oscillator

| Parameter         | Condition | Min | Typ       | Max | Unit |
|-------------------|-----------|-----|-----------|-----|------|
| Nominal Frequency |           | –   | 20.000    | –   | MHz  |
| Accuracy          |           | –   | $\pm 1.5$ | –   | %    |

#### 5.4.6 ADC Converter, $V_{3P3}$ Referenced

LSB values do not include the 9-bit left shift at EMP input.

| Parameter                                                                                                                   | Condition                                                      | Min  | Typ              | Max       | Unit                      |
|-----------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|------|------------------|-----------|---------------------------|
| Usable Input Range<br>( $V_{in}-V_{3P3}$ )                                                                                  |                                                                | -250 | –                | 250       | mV<br>peak                |
| THD (First 10 harmonics)                                                                                                    | $V_{in}=65\text{Hz}$ ,<br>64kpts FFT, Blackman-Harris window   | –    | -85              | –         | dB                        |
| Input Impedance                                                                                                             | $V_{in}=65\text{Hz}$                                           | 30   | –                | 90        | k $\Omega$                |
| Temperature coefficient of Input Impedance                                                                                  | $V_{in}=65\text{Hz}$                                           | –    | 1.7 <sup>1</sup> | –         | $\Omega/^{\circ}\text{C}$ |
| ADC Gain Error vs<br>%Power Supply Variation<br>$\frac{10^6 \Delta N_{out_{PK}} 357nV / V_{IN}}{100 \Delta V_{3P3A} / 3.3}$ | $V_{in}=200\text{mVpk}$ , 65Hz<br>$V_{3P3}=3.0\text{V}$ , 3.6V | –    | –                | <b>50</b> | ppm/%                     |
| Input Offset ( $V_{in}-V_{3P3}$ )                                                                                           |                                                                | -10  |                  | 10        | mV                        |

<sup>1</sup> Guaranteed by design, not subject to test.

## 5.5 Timing Specifications

### 5.5.1 RESET

| Parameter             | Condition | Min | Typ            | Max | Unit |
|-----------------------|-----------|-----|----------------|-----|------|
| Reset pulse fall time |           | –   | 1 <sup>1</sup> | –   | μs   |
| Reset pulse width     |           | –   | 5 <sup>1</sup> | –   | μs   |

<sup>1</sup> Guaranteed by design, not subject to test.

### 5.5.2 SPI Slave Port

| Parameter                                  | Condition                            | Min        | Typ            | Max | Unit     |
|--------------------------------------------|--------------------------------------|------------|----------------|-----|----------|
| $t_{SPIcyc}$ SCK cycle time                |                                      | 1          | –              | –   | μs       |
| $t_{SPILeas}$ Enable lead time             |                                      | 15         | –              | –   | ns       |
| $t_{SPILag}$ Enable lag time               |                                      | 0          | –              | –   | ns       |
| $t_{SPIW}$ SCK pulse width:<br>High<br>Low |                                      | 250<br>250 | –              | –   | ns<br>ns |
| $t_{SPISCK}$ SSB to first SCK fall         | Ignore if SCK is low when SSB falls. | –          | 2 <sup>1</sup> | –   | ns       |
| $t_{SPIDIS}$ Disable time                  |                                      | –          | 0 <sup>1</sup> | –   | ns       |
| $t_{SPIEV}$ SCK to Data Out (SDO)          |                                      |            | –              | 25  | ns       |
| $t_{SPISU}$ Data input setup time (SDI)    |                                      | 10         | –              | –   | ns       |
| $t_{SPIH}$ Data input hold time (SDI)      |                                      | 5          | –              | –   | ns       |

<sup>1</sup> Guaranteed by design, not subject to test.

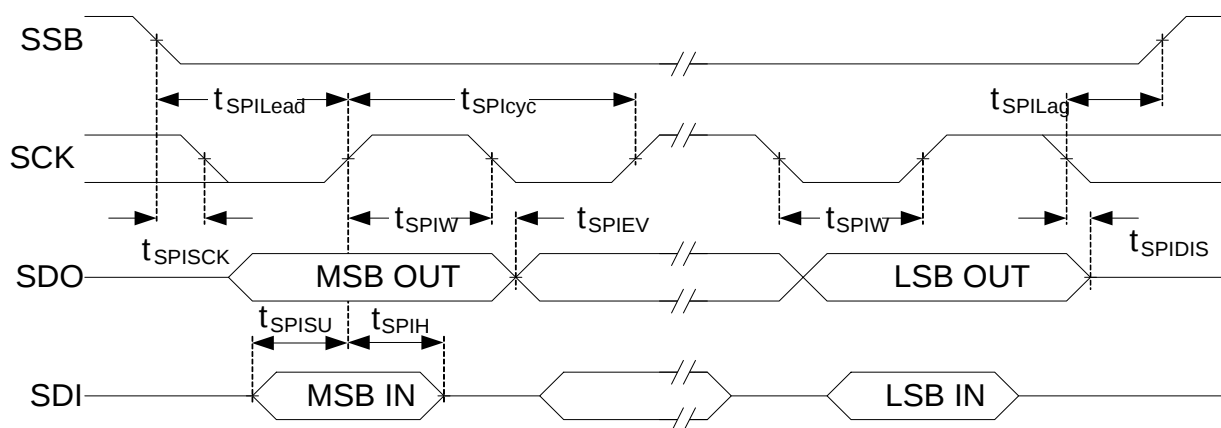


Figure 5-1: SPI Slave Port Timing

### 5.5.3 I<sup>2</sup>C Slave Port

Table 5-1: I<sup>2</sup>C Slave Port Timing<sup>2</sup>

| Parameter                                                                                                                  | Condition | Min             | Typ | Max | Unit |
|----------------------------------------------------------------------------------------------------------------------------|-----------|-----------------|-----|-----|------|
| $t_{BUF}$ Bus Idle (Free) time between transmissions (STOP/START)                                                          |           | 1500            | -   | —   | ns   |
| $t_{ICF}$ I <sup>2</sup> C input Fall Time                                                                                 |           | 20 <sup>1</sup> | —   | 300 | ns   |
| $t_{ICR}$ I <sup>2</sup> C input Rise Time                                                                                 |           | 20 <sup>1</sup> | —   | 300 | ns   |
| $t_{STH}$ I <sup>2</sup> C START or repeated START condition hold time                                                     |           | 500             | —   | —   | ns   |
| $t_{STS}$ I <sup>2</sup> C START or repeated START condition setup time                                                    |           | 600             | —   | —   | ns   |
| $t_{SCH}$ I <sup>2</sup> C clock high time                                                                                 |           | 600             | —   | —   | ns   |
| $t_{SCL}$ I <sup>2</sup> C clock low time                                                                                  |           | 1300            | —   | —   | ns   |
| $t_{SDS}$ I <sup>2</sup> C serial data setup time                                                                          |           | 100             | —   | —   | ns   |
| $t_{SDH}$ I <sup>2</sup> C serial data hold time                                                                           |           | 10              | —   | —   | ns   |
| $t_{VDA}$ I <sup>2</sup> C Valid data time:<br>- SCL low to SDA output valid<br>- ACK signal from SCL low to SDA (out) low |           | —               | —   | 900 | ns   |

Notes:

<sup>1</sup> Dependent on bus capacitance.

<sup>2</sup> Guaranteed by design, not subject to test.

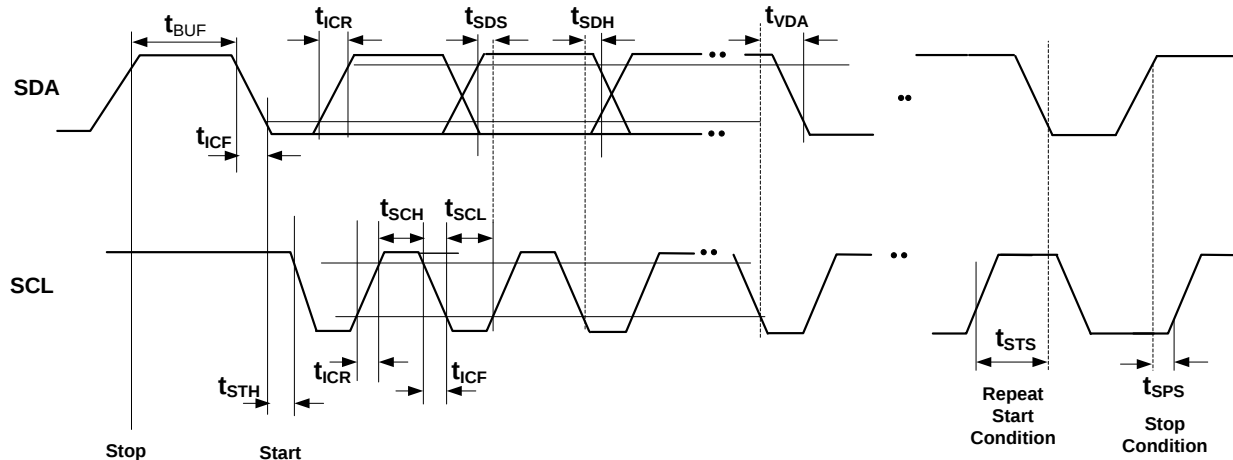
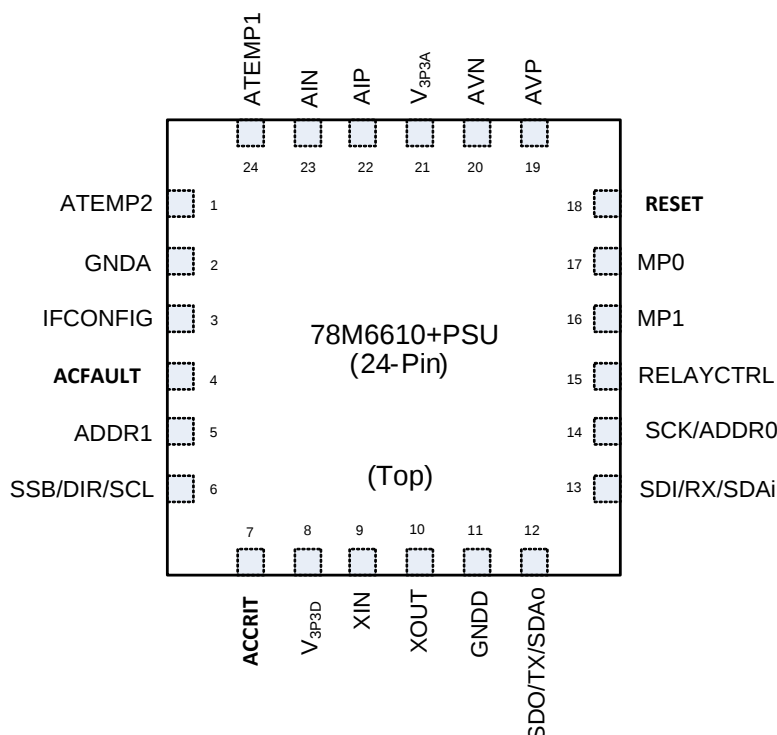


Figure 5-2: I<sup>2</sup>C (Slave) Port Timing

## 6 Packaging

### 6.1 24-Pin QFN Pinout

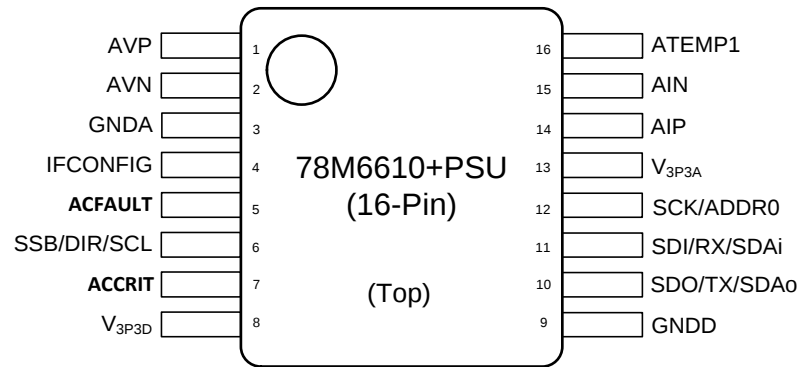


| Pin | Signal            | Function                                                                            | Pin | Signal            | Function                                                                    |
|-----|-------------------|-------------------------------------------------------------------------------------|-----|-------------------|-----------------------------------------------------------------------------|
| 1   | ATEMP2            | Thermistor 2 input                                                                  | 13  | SDI/RX/SDAi       | SPI DATA IN / UART RX/<br>I <sup>2</sup> C Data In                          |
| 2   | GNDA              | GROUND (Analog)                                                                     | 14  | SCK/ADDR0         | SPI CLOCK IN / I <sup>2</sup> C/Multi-<br>Point UART Address <sup>(1)</sup> |
| 3   | IFCONFIG          | UART/SPI (1=UART; 0=SPI) <sup>(1)</sup>                                             | 15  | RELAYCTRL         | Relay Control Output                                                        |
| 4   | ACFAULT           | ACFAULT Alarm                                                                       | 16  | MP0               | Multi-Purpose Digital I/O                                                   |
| 5   | ADDR1             | I <sup>2</sup> C/Multi-Point UART Address <sup>(1)</sup>                            | 17  | MP1               | Multi-Purpose Digital I/O                                                   |
| 6   | SSB/DIR/SCL       | Slave Select (SPI) / RS485 TX-<br>RX / I <sup>2</sup> C Serial Clock <sup>(1)</sup> | 18  | RESET             | Reset Input                                                                 |
| 7   | ACCRIT            | AC Voltage Alarm (Critical)                                                         | 19  | AVP               | Voltage Input (positive)                                                    |
| 8   | V <sub>3P3D</sub> | 3.3VDC Supply (Digital)                                                             | 20  | AVN               | Voltage Input (negative)                                                    |
| 9   | XIN               | Crystal Oscillator Driver Input                                                     | 21  | V <sub>3P3A</sub> | 3.3VDC Supply (Analog)                                                      |
| 10  | XOUT              | Crystal Oscillator Driver Output                                                    | 22  | AIP               | Current Input (positive)                                                    |
| 11  | GNDD              | GROUND (Digital)                                                                    | 23  | AIN               | Current Input (negative)                                                    |
| 12  | SDO/TX/SDAo       | SPI DATA OUT/ UART TX/<br>I <sup>2</sup> C Data Out                                 | 24  | ATEMP1            | Thermistor 1 input                                                          |

Notes:

- 1) Pin is sampled after power-on or reset to select/configure the communication peripheral

## 6.2 16-Pin TSSOP Pinout



| Pin | Signal            | Function                                                                        | Pin | Signal            | Function                                                                |
|-----|-------------------|---------------------------------------------------------------------------------|-----|-------------------|-------------------------------------------------------------------------|
| 1   | AVP               | Voltage Input (positive)                                                        | 9   | GNDD              | GROUND (Digital)                                                        |
| 2   | AVN               | Voltage Input (negative)                                                        | 10  | SDO/TX/SDAo       | SPI DATA OUT/ UART TX/ I <sup>2</sup> C Data Out                        |
| 3   | GNDA              | GROUND (Analog)                                                                 | 11  | SDI/RX/SDAi       | SPI DATA IN / UART RX/ I <sup>2</sup> C Data In                         |
| 4   | IFCONFIG          | UART/SPI (1=UART/I <sup>2</sup> C; 0=SPI) <sup>(1)</sup>                        | 12  | SCK/ADDR0         | SPI CLOCK IN / I <sup>2</sup> C/Multi-Point UART Address <sup>(1)</sup> |
| 5   | ACFAULT           | ACFAULT Alarm                                                                   | 13  | V <sub>3P3A</sub> | 3.3VDC Supply (Analog)                                                  |
| 6   | SSB/DIR/SCL       | Slave Select (SPI) / RS485 TX-RX / I <sup>2</sup> C Serial Clock <sup>(1)</sup> | 14  | AIP               | Current Input (positive)                                                |
| 7   | ACCRIT            | AC Voltage Alarm (Critical)                                                     | 15  | AIN               | Current Input (negative)                                                |
| 8   | V <sub>3P3D</sub> | 3.3VDC Supply (Digital)                                                         | 16  | ATEMP1            | Thermistor 1 input                                                      |

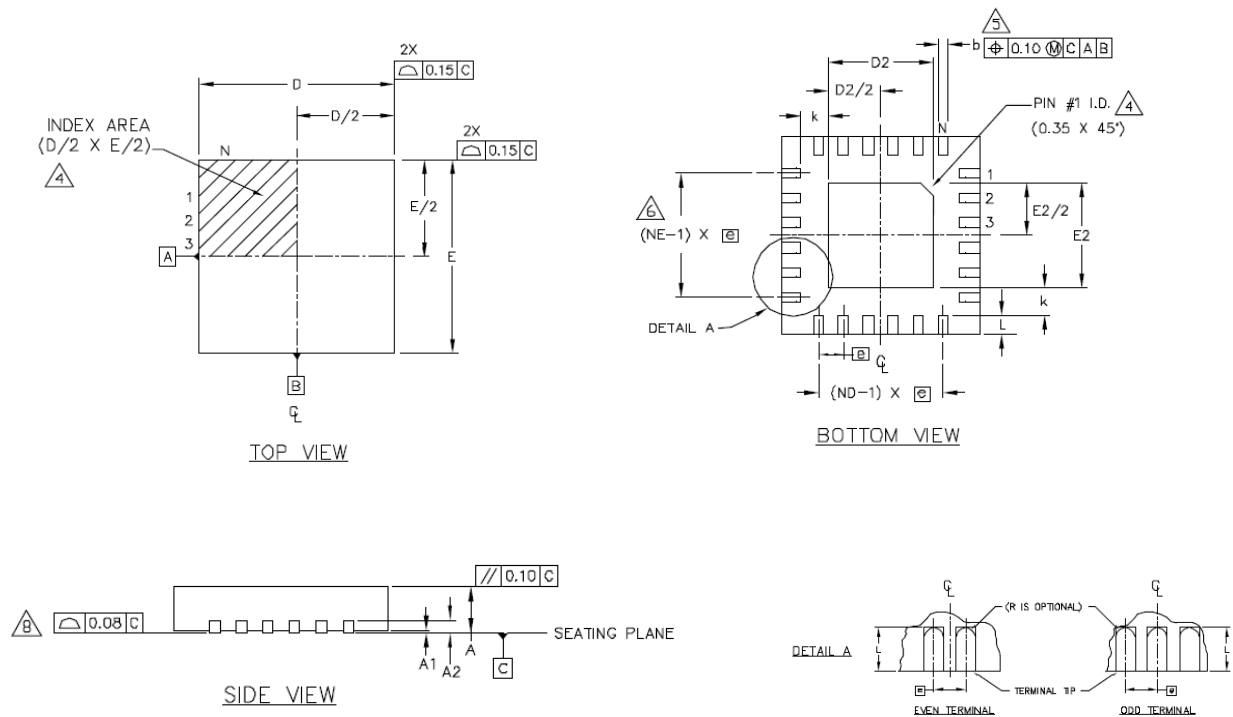
Notes:

- 1) Pin is sampled after power-on or reset to select/configure the communication peripheral

### 6.3 Package Outline

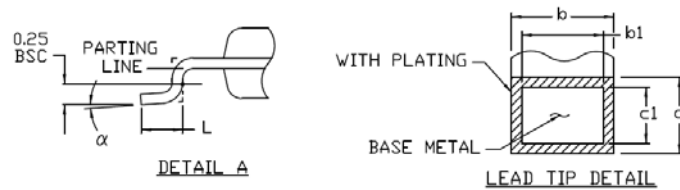
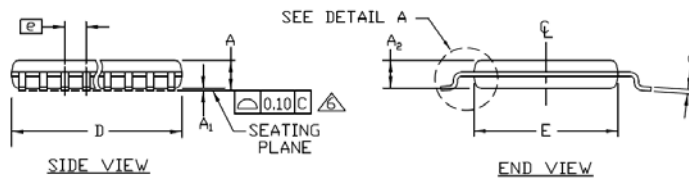
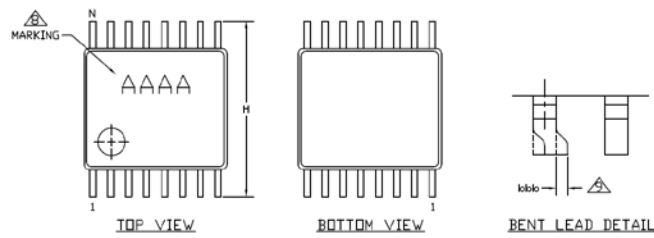
| PACAKGE TYPE | PACAKGE CODE | OUTLINE NO.             | LAND PATTERN NO.        |
|--------------|--------------|-------------------------|-------------------------|
| 24 QFN       | T2444+4      | <a href="#">21-0139</a> | <a href="#">90-0022</a> |
| 16 TSSOP     | U16+2        | <a href="#">21-0066</a> | <a href="#">90-0117</a> |

#### QFN-24 Package



| PKG        | 24L 4x4   |      |      |
|------------|-----------|------|------|
| REF.       | MIN.      | NOM. | MAX. |
| A          | 0.70      | 0.75 | 0.80 |
| A1         | 0.0       | 0.02 | 0.05 |
| A2         | 0.20 REF  |      |      |
| b          | 0.18      | 0.23 | 0.30 |
| D          | 3.90      | 4.00 | 4.10 |
| E          | 3.90      | 4.00 | 4.10 |
| e          | 0.50 BSC. |      |      |
| k          | 0.25      | -    | -    |
| L          | 0.30      | 0.40 | 0.50 |
| N          | 24        |      |      |
| ND         | 6         |      |      |
| NE         | 6         |      |      |
| Jedec Var. | WGGD-2    |      |      |

## TSSOP-16 Package



| SYMBOL         | COMMON DIMENSIONS |      |                |      |
|----------------|-------------------|------|----------------|------|
|                | MILLIMETERS       |      | INCHES         |      |
|                | MIN.              | MAX. | MIN.           | MAX. |
| A              | —                 | 1.10 | —              | .043 |
| A <sub>1</sub> | 0.05              | 0.15 | .002           | .006 |
| A <sub>2</sub> | 0.85              | 0.95 | .033           | .037 |
| b              | 0.19              | 0.30 | .007           | .012 |
| b <sub>1</sub> | 0.19              | 0.25 | .007           | .010 |
| c              | 0.09              | 0.20 | .004           | .008 |
| c <sub>1</sub> | 0.09              | 0.14 | .004           | .006 |
| D              | 4.90              | 5.10 | .193           | .201 |
| E              | 4.30              | 4.50 | .169           | .177 |
| e              | 0.65 BSC          |      | .026 BSC       |      |
| H              | 6.25              | 6.55 | .246           | .258 |
| L              | 0.50              | 0.70 | .020           | .028 |
| N              | SEE VARIATIONS    |      | SEE VARIATIONS |      |
| α              | 0°                | 8°   | 0°             | 8°   |
| bbb            | 0.10 MAX          |      |                |      |

## NOTES

1. DIMENSIONS D AND E DO NOT INCLUDE FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm PER SIDE
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC OUTLINE MO-153. SEE JEDEC VARIATIONS TABLE
5. "N" REFERS TO NUMBER OF LEADS
6. LEAD COPLANARITY 0.10 MM MAX.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY
8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY
9. BENT LEAD 0.10 MM MAX.
10. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
11. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PBFREE (+) PKG. CODES.

—DRAWING NOT TO SCALE—

## 7 Ordering Information

| Part        | Package  | Option      | Ordering Number  | IC Marking |
|-------------|----------|-------------|------------------|------------|
| 78M6610+PSU | QFN-24   | Bulk        | 78M6610+PSU/B00  | EMP        |
|             |          | Tape & Reel | 78M6610+PSU/B00T |            |
|             | TSSOP-16 | Bulk        | 78M6610+PSU/C00  |            |
|             |          | Tape & Reel | 78M6610+PSU/C00T |            |

## 8 Contact Information

For more information about the 78M6610+PSU or other Maxim Integrated products, contact technical support at [www.maximintegrated.com/support](http://www.maximintegrated.com/support).

**Revision History**

| REVISION<br>NUMBER | REVISION<br>DATE | DESCRIPTION                                                                                                             | PAGES<br>CHANGED                                   |
|--------------------|------------------|-------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------|
| 0                  | 7/12             | Initial release                                                                                                         | —                                                  |
| 1                  | 2/13             | Revised pin description, RC Oscillator Specification, X+Y capacitor calibration, and accumulation interval description  | 7, 12, 13,<br>19, 20, 40,<br>45, 54, 55,<br>58, 59 |
| 2                  | 4/14             | Updated the Command Register and SPI Interface sections; revised the SSI byte count description; updated related tables | 20, 21, 38,<br>39, 40, 48,<br>50                   |
| 3                  | 8/14             | Updated Storage Temperature parameter on the Electrical Characteristics table; Updated SPI Interface section            | 48-50, 55                                          |

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